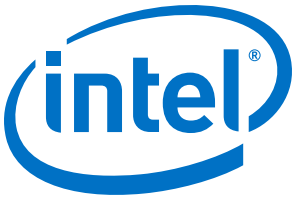

Intel Stratix 10 Embedded Memory User Guide

Updated for Intel® Quartus® Prime Design Suite: **18.0**

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1. Intel® Stratix® 10 Embedded Memory Overview

Intel® Stratix® 10 embedded memory blocks are flexible and provide an optimal amount of various sized memory arrays to fit your design requirements.

Related Information

HyperFlex Core Architecture, Intel Stratix 10 Device Overview
Provides more information about Hyper-Registers and the HyperFlex core architecture. Hyper-Registers are additional registers available in every interconnect routing segment throughout the core fabric, including the routing segments connected to the memory logic array block (MLAB) and M20K block inputs and outputs.

1.1. Intel Stratix 10 Embedded Memory Features

The Intel Stratix 10 devices contain three types of memory blocks: Embedded SRAM (eSRAM) blocks, M20K blocks, and memory logic array blocks (MLABs).

- 45-Megabit (Mb) eSRAM blocks
  - Fast path, low latency, high bandwidth and very high random transaction rate (RTR) on-chip memory block
  - Each block consists of 8 channels and each channel has 42 banks.
  - Each bank is configurable to 2K depth and 72-bit data width
  - Supports only simple dual-port RAM with concurrent read and write access per channel
- 20-kilobit (Kb) M20K blocks
  - Blocks of dedicated memory resources.
  - Ideal for larger memory arrays, while providing a large number of independent ports.
- 640-bit MLABs
  - Enhanced memory blocks configured from dual-purpose logic array blocks (LABs).
  - Ideal for wide and shallow memory arrays.
  - Optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines.
  - Each MLAB is made up of ten adaptive logic modules (ALMs).

In Intel Stratix 10 devices, you can configure each ALM in the MLAB as ten 32×2 blocks. The Intel Stratix 10 devices provide one 32×20 simple dual-port SRAM block per MLAB.

The Intel Stratix 10 embedded memory blocks support the following operation modes:

- Single-port
- Simple dual-port
- True dual-port
- Simple quad-port
- ROM

Table 1. Intel Stratix 10 Embedded Memory Features

This table summarizes the features supported by the Intel Stratix 10 embedded memory blocks.

Features	eSRAM	M20K	MLAB
Maximum operating frequency	750 MHz	• 1 GHz (simple dual-port RAM mode) • 600 MHz (true dual-port and simple quad-port RAM mode)	1 GHz
Total RAM bits (including parity bits)	45 Mb	20,480 bits	640 bits
Byte enable	—	Supported	Supported
Address clock enable	—	Supported (only in simple dual-port RAM mode)	Supported
Simple dual-port mixed width	—	Supported	—
FIFO buffer mixed width	—	Supported	—
Memory Initialization File (.mif)	—	Supported	Supported
Dual-clock mode	—	Supported (only in simple dual-port RAM mode)	Supported
Full synchronous memory	—	Supported	Supported
Asynchronous memory	—	–	Only for flow-through read memory operations
Power-up state	—	Output ports are cleared	• Registered output ports are cleared • Unregistered output ports read memory contents
Asynchronous/Synchronous Clears	—	Output registers and output latches	Output registers and output latches
Write/read operation triggering	Rising clock edges	Rising clock edges	Rising clock edges
Same-port read-during-write	—	Output ports set to *New Data* or *Don't Care*	Output ports set to *Don't Care*
Mixed-port read-during-write	Write-forwarding feature • ON = *New Data* • OFF = *Old Data*	• Simple Dual Port RAM: Output ports set to *Old Data* or *Don't Care* • True Dual Port RAM: Output ports set to *Don't Care* • Simple Quad Port: Output ports set to *new_a_old_b*	Output ports set to *New Data*, *Old Data*, or *Don't Care*

continued...

Features	eSRAM	M20K	MLAB
Error Correction Code (ECC) support	• Soft IP using the Intel Quartus® Prime software • Built-in support ×64-wide simple dual-port mode	• Soft IP using the Intel Quartus Prime software • Hard IP • Built-in support ×32-wide simple dual-port mode • Parity bits	Soft IP using the Intel Quartus Prime software
Force-to-Zero	—	Supported	—
Coherent read memory	—	Supported	—
Freeze logic	—	Supported	—
Hardware behavior	—	Supported	—
True dual ports (TDP) dual clock emulator	—	Supported	—

1.2. Intel Stratix 10 Embedded Memory Capacity

Table 2. Embedded Memory Capacity and Distribution in Intel Stratix 10 Devices

This table lists the embedded memory capacity for Intel Stratix 10 GX, Intel Stratix 10 MX, Intel Stratix 10 SX, and Intel Stratix 10 TX variants.

Variant	Product Line	eSRAM		M20K		MLAB		Total RAM Bit (Mbits)
		Block	RAM Bit (Mbits)	Block	RAM Bit (Mbits)	Block	RAM Bit (Mbits)	
Intel Stratix 10 GX	GX 400	NA	NA	1,537	30	3,276	2	32
	GX 650	NA	NA	2,489	49	5,364	3	52
	GX 850	NA	NA	3,477	68	7,124	4	72
	GX 1100	NA	NA	4,401	86	9,540	6	92
	GX 1650	NA	NA	5,851	114	13,764	8	122
	GX 2100	NA	NA	6,501	127	17,316	11	138
	GX 2500	NA	NA	9,963	195	20,529	13	208
	GX 2800	NA	NA	11,721	229	23,796	15	244
	GX 4500	NA	NA	7,033	137	37,821	23	160
	GX 5500	NA	NA	7,033	137	47,700	29	166
Intel Stratix 10 MX	MX 1100	1	45	4,401	86	6	45	176
	MX 1650	2	90	6,162	120	9	90	300
	MX 2100	2	90	6,847	134	11	90	314
Intel Stratix 10 SX	SX 400	NA	NA	1,537	30	3,276	2	32
	SX 650	NA	NA	2,489	49	5,364	3	52
	SX 850	NA	NA	3,477	68	7,124	4	72
	SX 1100	NA	NA	4,401	86	9,540	6	92
	SX 1650	NA	NA	5,851	114	13,764	8	122
	SX 2100	NA	NA	6,501	127	17,316	11	138

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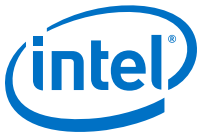


Variant	Product Line	eSRAM		M20K		MLAB		Total RAM Bit (Mbits)
		Block	RAM Bit (Mbits)	Block	RAM Bit (Mbits)	Block	RAM Bit (Mbits)	
	SX 2500	NA	NA	9,963	195	20,529	13	208
	SX 2800	NA	NA	11,721	229	23,796	15	244
	SX 4500	NA	NA	7,033	137	37,821	23	160
	SX 5500	NA	NA	7,033	137	47,700	29	166
Intel Stratix 10 TX	TX 1650	2	90	5,851	120	13,764	9	219
	TX 2100	2	90	6,501	134	17,316	11	235
	TX 2500	NA	NA	9,963	195	20,529	13	208
	TX 2800	NA	NA	11,721	229	23,796	15	244

2. Intel Stratix 10 Embedded Memory Architecture and Features

The Intel Stratix 10 embedded memory features include operation modes, clocking modes, and configurations.

2.1. Byte Enable in Intel Stratix 10 Embedded Memory Blocks

The Intel Stratix 10 embedded memory blocks support byte enable controls.

- The byte enable controls mask the input data so that only specific bytes of data are written. The unwritten bytes retain the values written previously.
- The write enable (`wren`) signal, together with the byte enable (`byteena`) signal, control the write operations on the embedded memory blocks. By default, the `byteena` signal is high (enabled) and only the `wren` signal controls the writing.
- The byte enable registers do not have a `clear` port.
- Byte enable operates in one-hot fashion. The LSB of the `byteena` signal corresponds to the LSB of the data bus.
- The byte enable signals are active high.

2.1.1. Byte Enable Controls

Table 3. Byte Enable Controls in ×10 Data Width (MLAB)

byteena[1:0]	Data Bits Written	
11 (default)	[9:5]	[4:0]
10	[9:5]	–
01	–	[4:0]
00	–	–

Table 4. Byte Enable Controls in ×20 Data Width (M20K)

byteena[1:0]	Data Bits Written	
11 (default)	[19:10]	[9:0]
10	[19:10]	–
01	–	[9:0]
00	–	–

Table 5. Byte Enable Controls in ×40 Data Width (M20K)

byteena[3:0]	Data Bits Written			
1111 (default)	[39:30]	[29:20]	[19:10]	[9:0]
1000	[39:30]	–	–	–
0100	–	[29:20]	–	–
0010	–	–	[19:10]	–
0001	–	–	–	[9:0]
0000	–	–	–	–

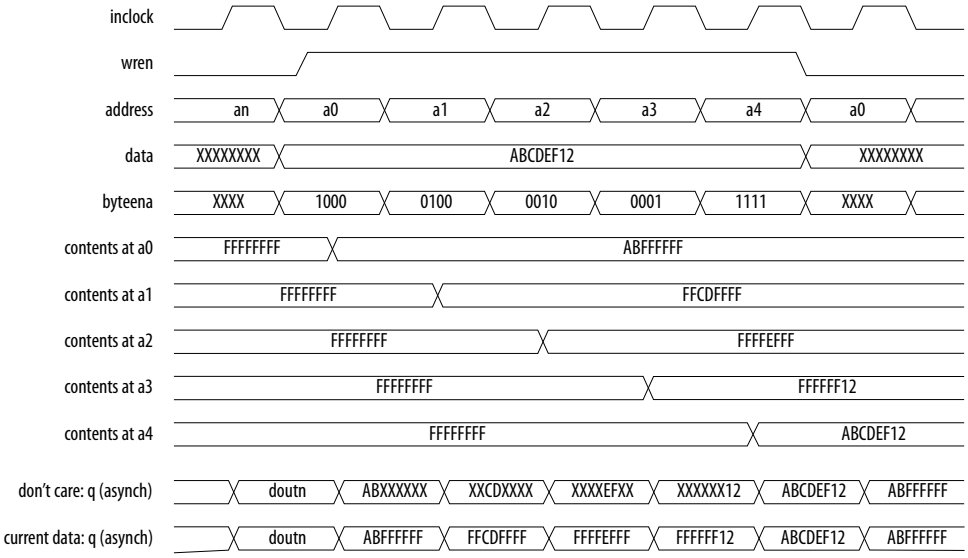
2.1.2. Data Byte Output

In M20K blocks or MLABs, when you deassert a byte-enable bit to 0 during a write cycle, the corresponding data byte output appears as either a *Don't Care* value, or the current data at that location. You can control the output value for the masked byte in the M20K blocks or MLABs in the same-port read-during-write mode by using the Platform Designer in Intel Quartus Prime software.

2.1.3. Byte Enable Behavior

Figure 1. Byte Enable Functional Waveform

This figure shows how the `wren` and `byteena` signals control the operations of the embedded memory blocks.



2.2. Address Clock Enable Support

Intel Stratix 10 embedded memory blocks support address clock enable. When you enable address clock enable (`addressstall` = 1), it holds the previous address value.

Note: Only simple dual-port mode supports this feature.

When you configure the memory blocks in dual-port mode, each port has its own independent address clock enable.

Figure 2. Address Clock Enable

This figure shows an address clock enable block diagram.

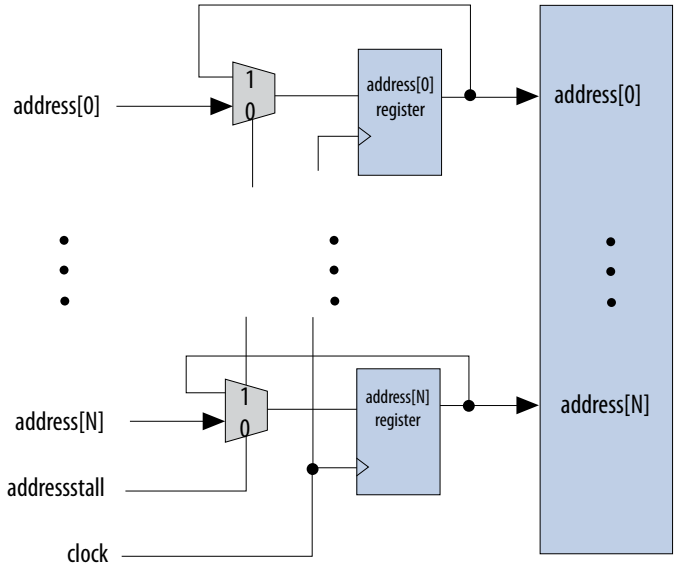


Figure 3. Address Clock Enable During Read Cycle

This figure shows the address clock enable behavior during read cycle.

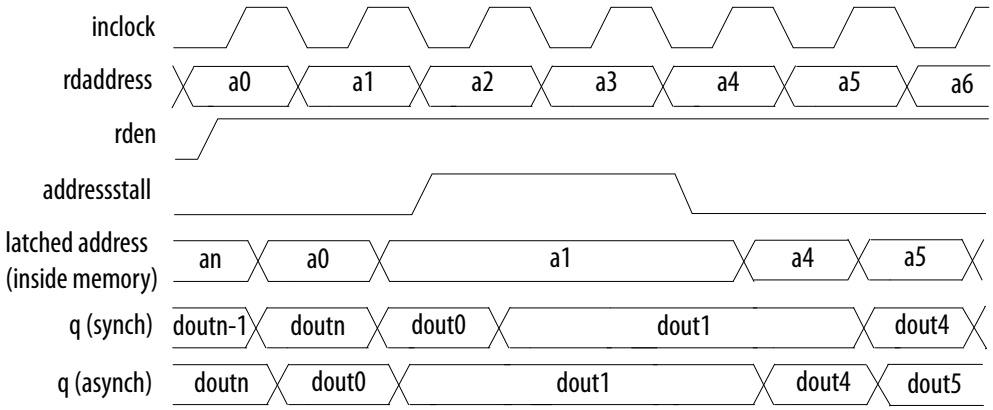
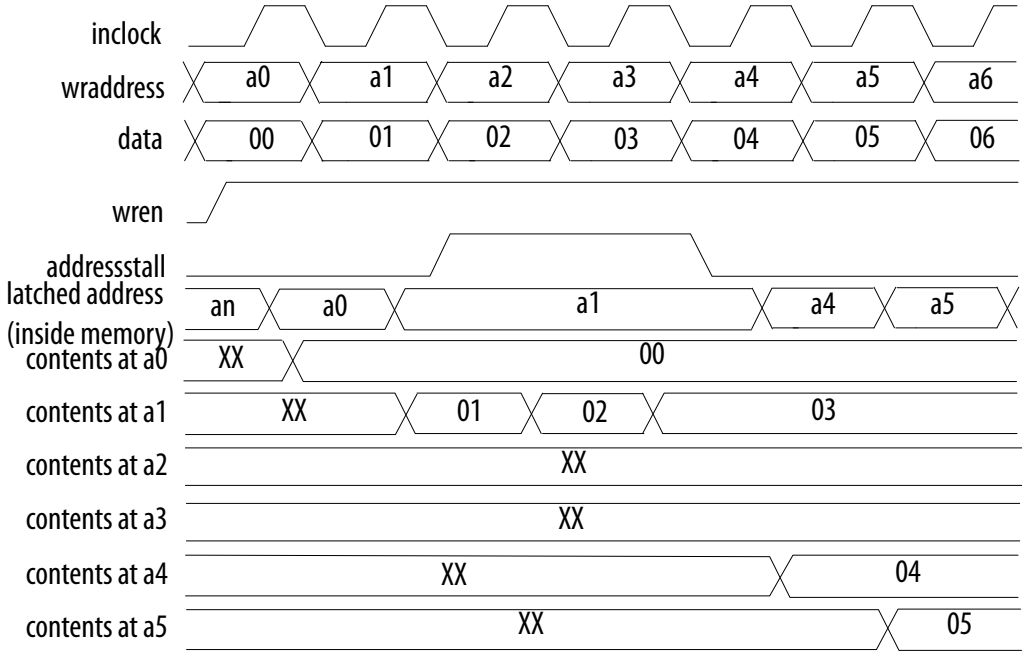


Figure 4. Address Clock Enable During Write Cycle

This figure shows the address clock enable behavior during write cycle.



2.3. Asynchronous Clear and Synchronous Clear

The embedded memory blocks support asynchronous clear and synchronous clear on output latches and output registers.

If your RAM does not use output registers, the RAM outputs are cleared using the latch asynchronous clear (`aclr`). The (`aclr`) signal is generated at any time. The internal logic extends the clear pulse until the next rising edge of the output clock. When the `aclr` signal asserts, the outputs are cleared and stay cleared until the next read cycle.

For the synchronous clear (`sclr`) signal, the RAM outputs are cleared at the next rising edge of the output clock when the (`sclr`) signal is asserted. The outputs will stay cleared until the next read cycle.

Note: Both `aclr` and `sclr` signals must be used separately for each RAM configuration.

Figure 5. Behavior of Asynchronous Clear and Synchronous Clear in Registered Mode

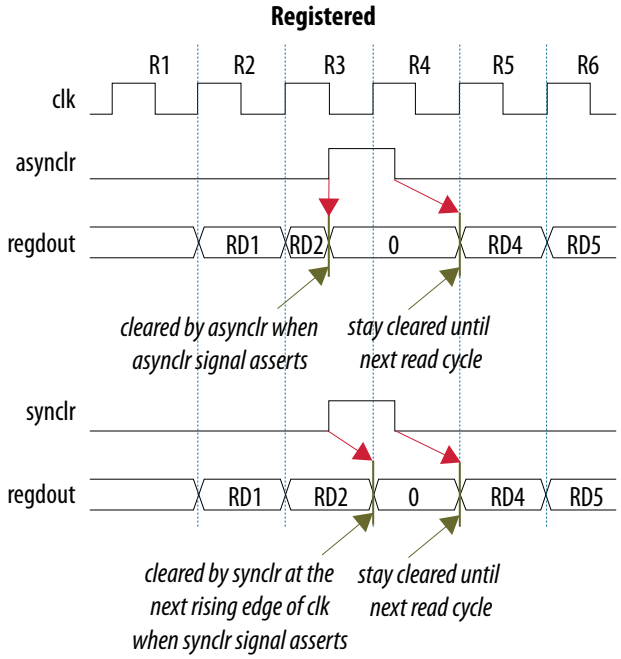
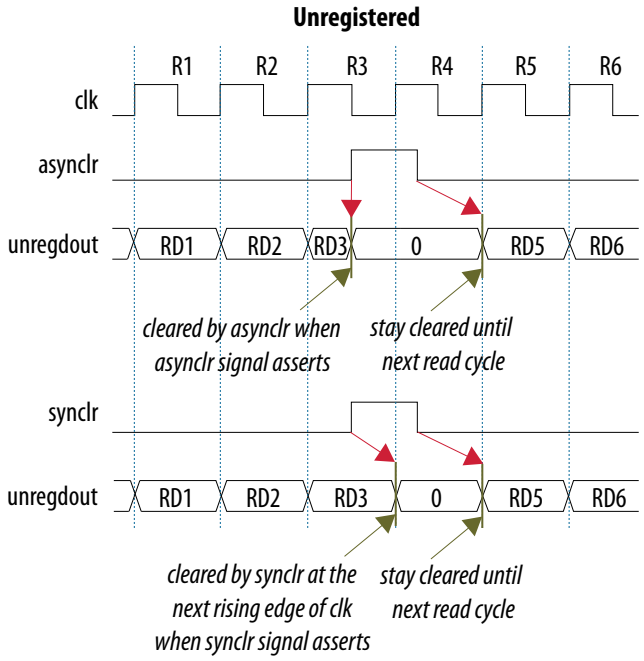


Figure 6. Behavior for Asynchronous Clear and Synchronous Clear in Unregistered Mode



2.4. Memory Blocks Error Correction Code Support

ECC detects and corrects data errors at the output of the memory.

Only M20K blocks and eSRAM blocks support the ECC feature.

If you engage the ECC feature, you cannot use the following features:

- Byte enable
- Coherent read

M20K Blocks

For M20K blocks, ECC performs single-error correction, double-adjacent-error correction, and triple-adjacent-error correction in a 32-bit word. However, ECC cannot guarantee detection or correction of non-adjacent two-bit or more errors.

The M20K blocks have built-in support for ECC when in ×32-wide simple dual-port mode.

- When you engage the ECC feature, the M20K runs slower than the non-ECC simple-dual port mode. However, you can enable optional ECC pipeline registers before the output decoder to achieve higher performance compared to non-pipeline ECC mode at the expense of one-cycle latency.
- Two ECC status flag signals—`e` (error) and `ue` (uncorrectable error) indicate the M20K ECC status. The status flags are part of the regular outputs from the memory block. When you engage ECC, you cannot access two of the parity bits because the ECC status flag replaces them.

eSRAM Blocks

For eSRAM blocks, ECC performs single-error correction and double-error detection in a 64-bit word.

The eSRAM blocks have built-in support for ECC when in ×64-wide simple dual-port mode.

- Two ECC status flag signals—`c{7:0}_error_correct_0` (error corrected) and `c{7:0}_error_detect_0` (error detected) indicate the eSRAM ECC status.

2.4.1. Parity Bit

The following describes the parity bit support for M20K blocks:

- 8 parity bits are generated through the ECC encoder based on 32-bit input data width, resulting in up to a total of 40 bits of data width.
- You can inject and flip the parity bits by using the ECC parity flip feature.

2.4.2. ECC Parity Flip

The ECC parity flip feature dynamically flips the parity value generated in the encoder of M20K blocks to observe the ECC behavior through simulation.

When the ECC Encoder Bypass (`eccencbypass`) port is high, the built-in ECC encoder values are XOR-ed with the 8 parity bits through the parity ports to generate a new set of encoder value. When the ECC Encoder Bypass port is low, the encoder generates the parity bits according to the data input during a write process.

The following table shows an example to construct an 8-bit data width for the parity port.

Table 6. Example of Setting the 8-Bit Parity Ports

Parity Bit Sequence	ECC Feature	Is the ECC Decoder able to Recognize and Correct the Data Bit?
00000001	Single-error correction	Yes
00000011	Double-adjacent-error correction	Yes
00000111	Triple-adjacent-error correction	Yes
00000101	Triple-adjacent-error correction	Yes
00010011	Non-adjacent double/triple correction/detection	No guarantee

2.4.3. ECC Read-During-Write Behavior

For M20K blocks, you can select either *Old Data* or *Don't Care* output mode. By default, the mixed port read-during-write mode is set to *Don't Care*. When the mixed port read-during-write is set as *Don't Care*, both RAM data output and `eccstatus` will be 'X'. However, if the mixed port read-during-write mode is set as *Old Data*, the RAM data output will be the old data and the ECC status will be a deterministic value.

2.4.4. Error Correction Code Truth Table

Table 7. ECC Status Flags Truth Table for M20K

Eccstatus[1]e	Eccstatus[0]ue	Status
0	0	No error.
0	1	Illegal/Invalid.
1	0	A correctable error occurred and the error has been corrected at the outputs; however, the memory array has not been updated.
1	1	An uncorrectable error occurs and uncorrectable data appears at the outputs.

Figure 7. ECC Block Diagram for M20K Memory

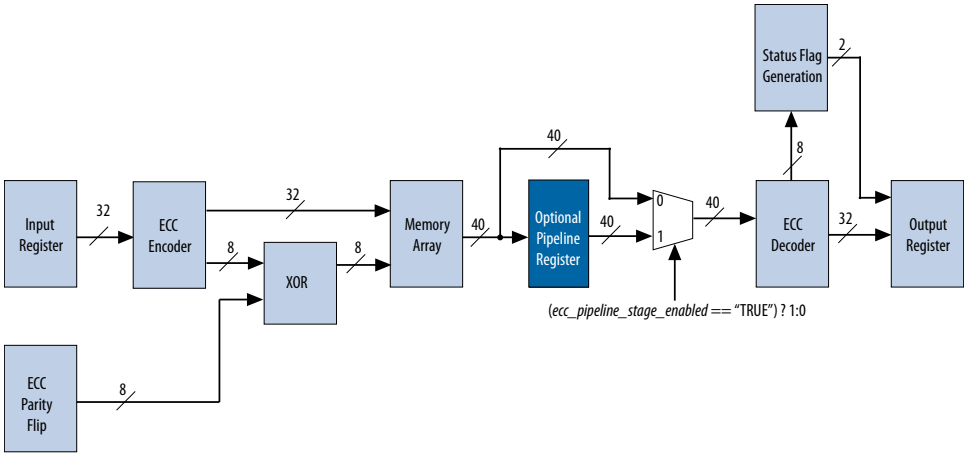


Table 8. ECC Status Flags Truth Table for eSRAM

C{7:0}_error_detect_0	C{7:0}_error_correct_0	Status
0	0	No error.
0	1	Illegal.
1	0	An error is detected but uncorrectable. The uncorrectable data appears at the outputs.
1	1	An error is detected and correctable. The error has been corrected at the outputs. The corrected data appears at the outputs but the memory array is not updated.

2.5. Force-to-Zero

The Force-to-Zero feature helps improve timing when a RAM memory block selected is larger than a single memory block. This feature is applicable only for M20K blocks.

For example, if the selected RAM memory block has a memory depth of 4096, the M20K block, which supports only a maximum memory depth of 2048, will require two RAMs to be multiplexed together. When you engage with this feature, When you engage with this feature, you can replace OR gate with multiplexing circuitry at the output of the M20K block when performing address width stitching. As the MSB of address controls the read enable signal in the Force-to-Zero mode, the outputs of other memory blocks are forced to zero when the read enable signal is deasserted. This results the data output being read out from the output of the selected memory block only.

You have the option to turn on **Enable Force-to-Zero feature** in the parameter editors of the RAM/ROM IP cores.

Note: When you turn on **Enable Force-to-Zero feature**, the read enable signal does not retain previous values when you deassert the signal.

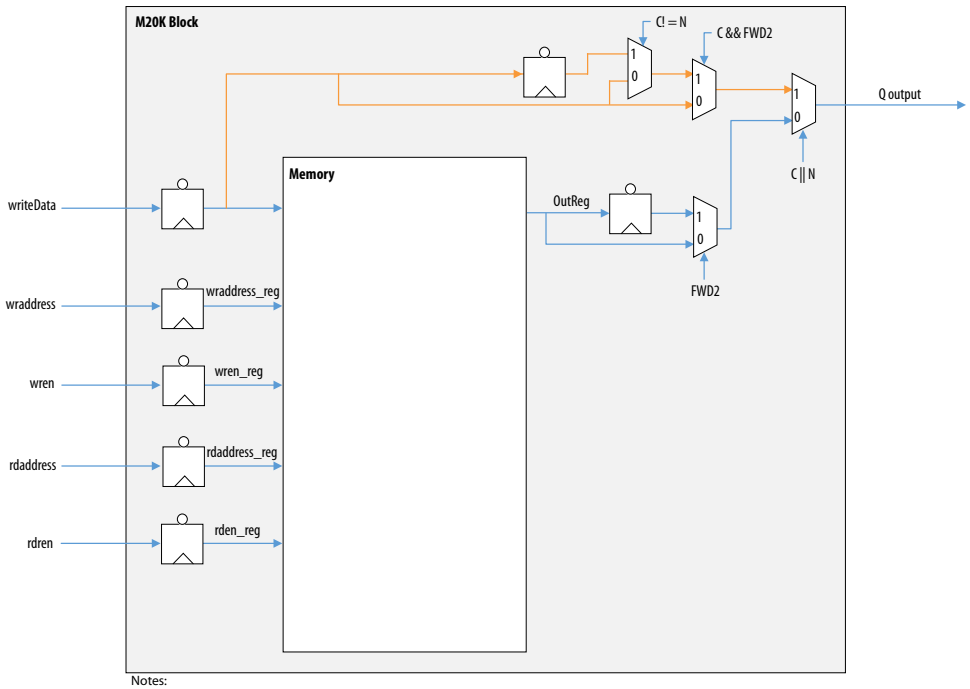
2.6. Coherent Read Memory

The coherent memory feature allows you to read out the output data that will be written into the same memory content in a single clock cycle. In other words, you will experience the new data (flow through) behavior during the read-during-write operation. This feature is applicable only for M20K blocks and supported only in single clock configuration.

If you engage the coherent read memory feature, you cannot use the following configurations:

- Operating modes other than simple dual-port
- Simple dual-port with different port width
- Byte enable
- ECC
- Wide simple dual-port
- Dual clock configuration

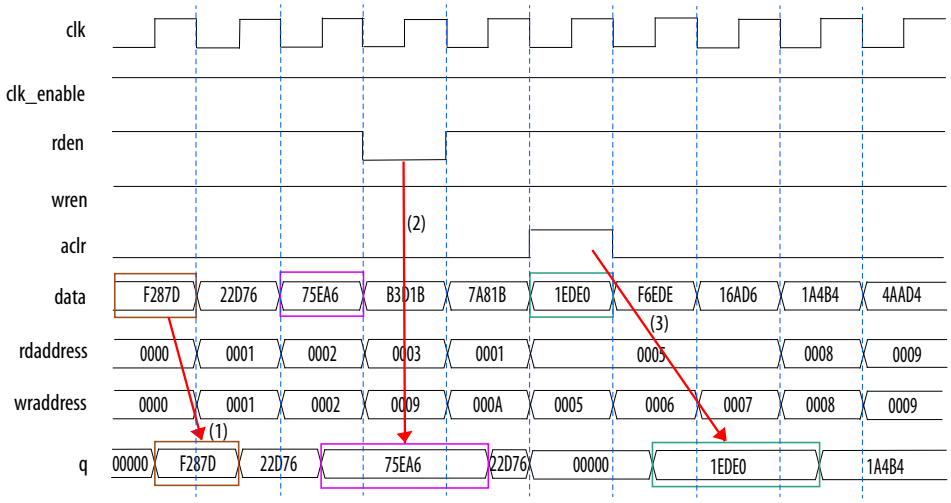
Figure 8. Simplified Block Diagram of Coherent Read Memory Circuitry



Notes:
1. N = (rden_reg && wren && (rdaddress_reg == wraddress)) ? 1 : 0.
2. C = (rden_reg && wren_reg && (rdaddress_reg == wraddress_reg)) ? 1 : 0.
3. FWD2 = (forwarding_stage2) ? 1 : 0.

Figure 9. Coherent Read Memory Behavior for Unregistered Output

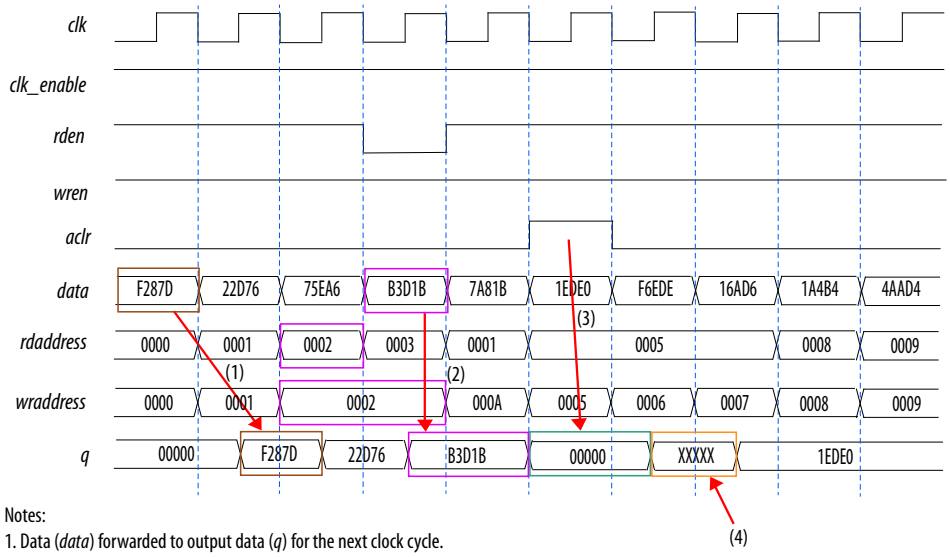
This figure shows the waveform of the coherent read memory when the output data is unregistered.



Notes:
1. Data (*data*) forwarded to output data (*q*) at the same clock cycle.
2. *rden* is low, *q* holds the forwarded value.
3. One clock cycle is needed to recover the *q* after clear (*aclr*) for the unregistered condition.

Figure 10. Coherent Read Memory Behavior for Registered Output

This figure shows the waveform of the coherent read memory when the output data is registered.



Notes:

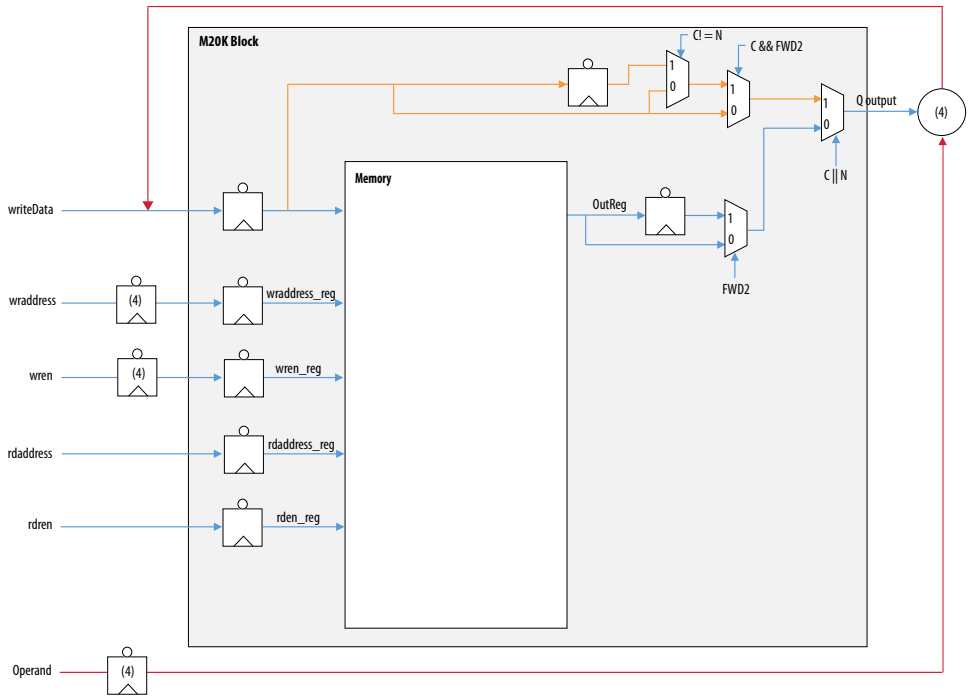
1. Data (*data*) forwarded to output data (*q*) for the next clock cycle.
2. *data* forwarded to *q* at the same clock cycle as current *wraddress* is the same as previous *rdaddress*.
3. When clear (*aclr*) is asserted, the M20K block clears *q*.
4. At this interval, *q* will latch from the M20K block, which is a Don't Care value, due to the read-during-write operation.

2.6.1. Forwarding Logic

In pipelining, you can use forwarding logic to perform data forwarding to reduce instruction cycles.

With coherent read feature and forwarding logic, you can coherently read out the data, perform operations (arithmetic or logical or both) on top of the data content, and write the data back to the same memory location within a single clock cycle.

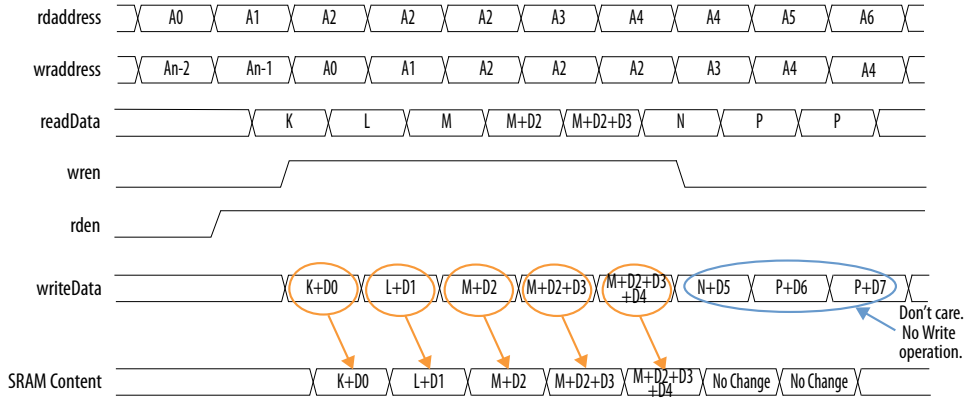
Figure 11. Example Forwarding Logic with Simplified Coherent Read Memory Circuitry



Notes:
1. N = (rden_reg && wren && (rdaddress_reg == wraddress)) ? 1 : 0.
2. C = (rden_reg && wren_reg && (rdaddress_reg == wraddress_reg)) ? 1 : 0.
3. FWD2 = (forwarding_stage2) ? 1 : 0.
4. External user logic added to achieve data forwarding.

Figure 12. Pipelining Waveform When Output of M20K Blocks is Unregistered

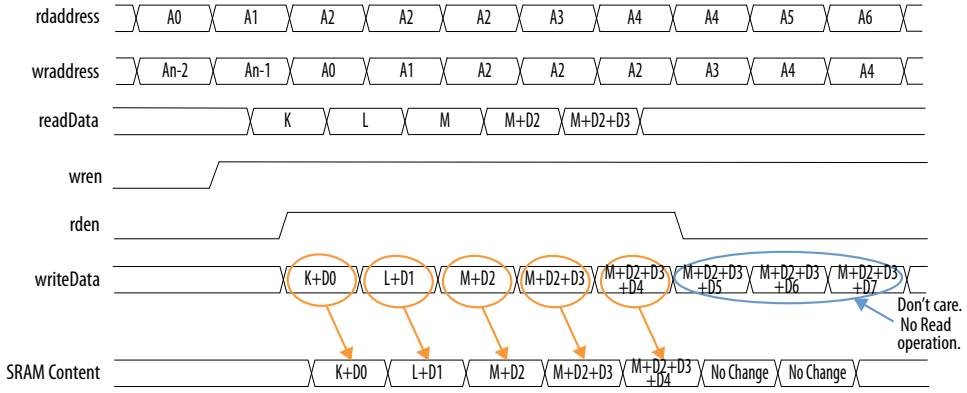
This figure shows the waveform of the pipelining with the read enable (rden) signal is high.



Note: All plus signs shown in this figure are example arithmetic operations performed on the data.

Figure 13. Pipelining Waveform When Output of M20K Blocks is Registered

This figure shows the waveform of the pipelining with the write enable (`wren`) signal is high.



Note: All plus signs shown in this figure are example arithmetic operations performed on the data.

With the coherent read feature enabled and forwarding logic implemented, the output of M20K blocks can be either unregistered or registered. To match the latency of the coherency circuitry within the hardware boundary of the M20K blocks, you may need to manually add the additional pipeline registers on the `wren` and `wraddress` paths, which is described in the following table:

Table 9. Pipeline Registers Requirements

Output Register	Additional Pipeline Registers on `wren` and `wraddress`
Unregistered	0
Registered	1

2.7. Intel Stratix 10 Supported Embedded Memory IP Cores

Table 10. Intel Stratix 10 Memory IP Cores

This table lists and describes the IP cores that are supported in the Intel Stratix 10 embedded memory blocks.

IP Core	Supported Memory Mode	M20K Support	MLAB Support	Description
RAM: 1-PORT Intel FPGA IP	Single-port RAM	Yes	Yes	You can perform only one read or one write operation at a time. Use the read enable port to control the RAM output ports behavior during a write operation: • To retain the previous values that are held during the most recent active read enable—create a read-enable port and perform the write operation with the read enable port deasserted. • To show the new data being written, the old data at that address, or a *Don't Care* value when read-during-write occurs at the same address location—do not create a read-enable signal, or activate the read enable during a write operation.
RAM: 2-PORT Intel FPGA IP	Simple dual-port RAM	Yes	Yes	You can simultaneously perform one read and one write operations to different locations where the write operation happens on port A and the read operation happens on port B.

continued...

IP Core	Supported Memory Mode	M20K Support	MLAB Support	Description
RAM: 2-PORT Intel FPGA IP	True dual-port RAM	Yes	–	You can perform any combination of two port operations: two reads, two writes, or one read and one write at single clocking mode.
RAM: 4-PORT Intel FPGA IP	Simple quad-port RAM	Yes	–	You can simultaneously perform two read and two write operations to different locations where the write addresses are specified at `address_a` and `address_b` signal/port, and the read addresses are specified at `address2_a` and `address2_b` signal/port.
ROM: 1-PORT Intel FPGA IP	Single-port ROM	Yes	Yes	Only one address port is available for read operation. You can use the memory blocks as ROM. • Initialize the ROM contents of the memory blocks using a **.mif** or **.hex**. • The address lines of the ROM are registered on M20K blocks but can be unregistered on MLABs. • The outputs can be registered or unregistered. • The output registers can be asynchronously or synchronously cleared. • The ROM read operation is identical to the read operation in the single-port RAM configuration.
ROM: 2 PORT Intel FPGA IP	Dual-port ROM	Yes	No	The dual-port ROM has almost similar functional ports as single-port ROM. The difference is dual-port ROM has an additional address port for read operation. You can use the memory blocks as a ROM. • Initialize the ROM contents of the memory blocks using a **.mif** or **.hex**. • The address lines of the ROM are registered on M20K blocks. • The outputs can be registered or unregistered. • The output registers can be asynchronously or synchronously cleared. • The ROM read operation is identical to the read operation in the true dual-port RAM configuration.
Shift-register	—	Yes	Yes	Use the memory blocks as a shift-register block to save logic cells and routing resources. This mode is useful in DSP applications that require local data storage such as finite impulse response (FIR) filters, pseudo-random number generators, multi-channel filtering, and auto- and cross- correlation functions. Traditionally, the local data storage is implemented with standard flip-flops that exhaust many logic cells for large shift registers. The input data width (w), the length of the taps (m), and the number of taps (n) determine the size of a shift register (w × m × n). You can cascade memory blocks to implement larger shift registers.
FIFO Intel FPGA IP FIFO2 Intel FPGA IP	—	Yes	Yes	You can use the memory blocks as FIFO buffers. Use the SCFIFO and DCFIFO functions to implement single- and dual-clock asynchronous FIFO buffers in your design. For designs with many small and shallow FIFO buffers, the MLABs are ideal for the FIFO mode. However, the MLABs do not support mixed-width FIFO mode.

Caution: To avoid corrupting the memory contents, do not violate the setup time or hold time on any of the embedded memory block input registers during read and write operations. This limitation is applicable if you use the memory blocks in single-port RAM, simple dual-port RAM, true dual-port RAM, simple quad-port RAM, or ROM mode.

Related Information

RAM-Based Shift Register (ALTSHIFT_TAPS) IP Core User Guide

2.8. Intel Stratix 10 Embedded Memory Clocking Modes

Each Intel Stratix 10 embedded memory operation mode has supporting clocking modes.

Table 11. Memory Blocks Clocking Modes Supported for Each Memory Mode

Clocking Mode	Memory Mode					
	Single-Port	Simple Dual-Port	True Dual-Port	Simple Quad-Port	Single-Port ROM	Dual-Port ROM
Single clock mode	Yes	Yes	Yes	Yes	Yes	Yes
Read/write clock mode	–	Yes	– (1)	–	–	—
Input/output clock mode	Yes	Yes	Yes	– (2)	Yes	Yes

Note: The clock enable signals are supported for write address, byte enable, and data input registers on MLAB blocks.

2.8.1. Single Clock Mode

In the single clock mode, a single clock, together with a clock enable, controls all registers of the embedded memory block.

2.8.2. Read/Write Clock Mode

In the read/write clock mode, a separate clock is available for each read and write port.

- A read clock controls the data-output, read-address, and read-enable registers.
- A write clock controls the data-input, write-address, write-enable, and byte enable registers.

2.8.3. Input/Output Clock Mode

In input/output clock mode, a separate clock is available for each input and output port.

- An input clock controls all registers related to the data input to the embedded memory block including data, address, byte enables, read enables, and write enables.
- An output clock controls the data output registers.

(1) The read/write clock mode is done through emulated true dual-port. For more information on the emulated true dual-port, refer to the True Dual Ports Dual Emulator section.

(2) Both input and output modes share the same clock.

2.8.4. Asynchronous/Synchronous Clears in Clocking Modes

In all clocking modes, asynchronous and synchronous clears are available only for output latches and output registers.

For the independent (read/write and input/output) clock modes, the asynchronous and synchronous clears are available on both ports.

2.8.5. Output Read Data in Simultaneous Read/Write

If you perform a simultaneous read/write to the same address location using the read/write clock mode, the output read data is unknown. If you require the output read data to be a known value, use single-clock or input/output clock mode and select the appropriate read-during-write behavior in the parameter editors of the RAM/ROM IP cores.

2.8.6. Independent Clock Enables in Clocking Modes

Independent clock enables are supported in the following clocking modes:

- Read/write clock mode—supported for both read and write clocks.
- Input/output clock mode—supported for the registers of both ports.

To save power, you can control the shutdown of a particular register using the clock enables.

2.9. Intel Stratix 10 Embedded Memory Configurations

Table 12. Supported Embedded Memory Block Configurations

This table lists the maximum configurations supported for the Intel Stratix 10 embedded memory blocks.

Embedded Memory Block	Depth (bits)	Programmable Width
MLAB	32	×16, ×18, or ×20
M20K	512	×32 or ×40 *Note:* For simple dual-port only.
	1024	×16 or ×20 *Note:* For simple dual-port and true dual-port.
	2048	×8 or ×10 *Note:* For simple dual-port, true dual-port, and simple quad-port.
eSRAM	2048×42 (3)	x72 (3)

Note:

Related Information

eSRAM Intel FPGA IP on page 57

(3) The eSRAM channel depth and width can be programmably reduced to realize power savings. Refer to *eSRAM Intel FPGA IP Core* section for further details.

2.9.1. Mixed-Width Port Configurations

The mixed-width port configuration is supported only in simple dual-port RAM memory operation modes.

Note: MLABs do not support mixed-width port configurations.

Table 13. Supported Mixed-width Ratios for Intel Stratix 10

Operation Mode	Mixed-width Ratio	
	Without Byte Enable	With Byte Enable
Simple dual-port	1, 2, 4, 8, 16, and 32 *Note:* 8, 16, and 32 are emulated. For emulated ratio, use the `.mif` dimension of the larger width port.	1, 2, and 4
True dual-port	1	1
Simple quad-port	1	1

2.10. Freeze Logic

The freeze logic feature specifies whether to implement clock-enable circuitry for use in a partial reconfiguration region.

This feature is applicable only to the RAM modes:

- Single-port RAM
- Dual-port RAM
- Quad-port RAM

You have the option to turn on **Implement clock-enable circuitry for use in a partial reconfiguration** to enable the freeze logic feature in the parameter editors of the RAM IP cores.

2.11. Hardware Behavior

The Intel Stratix 10 embedded memory blocks provide both corrupting and non-corrupting hardware behaviors using dual concurrent write operation on the same address. This feature is applicable if you use the memory blocks in true dual-port and single quad-port modes.

By default, the memory blocks will corrupt upon the dual concurrent write at the same address. To show a non-corrupting hardware behavior in the memory blocks, include the user-defined option “ENA_NON_CORRUPT=1” in the simulator setup script.

When the dual concurrent write occurs, the physical emulation uses a time-division multiplexing method to multiplex Port A and Port B together under the same data width. In this sequence, the value of Port B will be written first, followed by the value of Port A at the same address. This results the value of Port A being written to the memory.

2.12. True Dual Ports Dual Clock Emulator

The true dual ports (TDP) dual clock emulator feature emulates a TDP dual clock mode. This feature provides backward compatibility with Intel Arria 10 devices, which supports TDP dual clock mode.

This feature is supported only in the following conditions:

- Two read/write ports operation mode
- Customize clocks for A and B ports clocking mode

Note: You must turn on **Emulate TDP dual clock mode** to enable the TDP dual clock emulator feature in the parameter editors of the dual-port RAM IP core.

The TDP dual clock emulator consists of two DCFIFOs and a single RAM block. The DCFIFO handles clock domain crossing (CDC) issues for the control signals and is a temporary buffer for data storage before and after being processed by the RAM block.

Due to the non-deterministic latency caused by different clock frequencies, a `valid` signal is introduced to identify whether the output data is valid. If the `valid` signal is de-asserted, discard the output data.

Table 14. Differences between Intel Stratix 10 Emulated TDP Dual Clock Mode and Intel Arria 10 TDP Dual Clock Mode

Signal	Intel Stratix 10 Emulated TDP Dual Clock Mode	Intel Arria 10 TDP Dual Clock Mode
`clocken`	Supported	Supported
`rden`	Supported	Supported
`wren`	Supported	Supported
`aclr`	—	Supported
`sclr`	—	Supported
`byteena`	—	Supported

For this feature to work properly, the clock ports must be connected properly. The clock connection to Port A must be a slow clock (clock A) and the clock connection to Port B must be a fast clock (clock B).

When you engage the TDP dual clock emulator feature, port A and port B will have different latency. The latency for port A decreases as the difference between the two clock frequencies increase, with a minimum latency of four clock cyles. Port B latency is fixed to two clock cycles, with the output registers always enabled for this configuration.

The following figures show the timing diagrams for the TDP dual clock emulator feature.

Figure 14. Output Condition of Port A

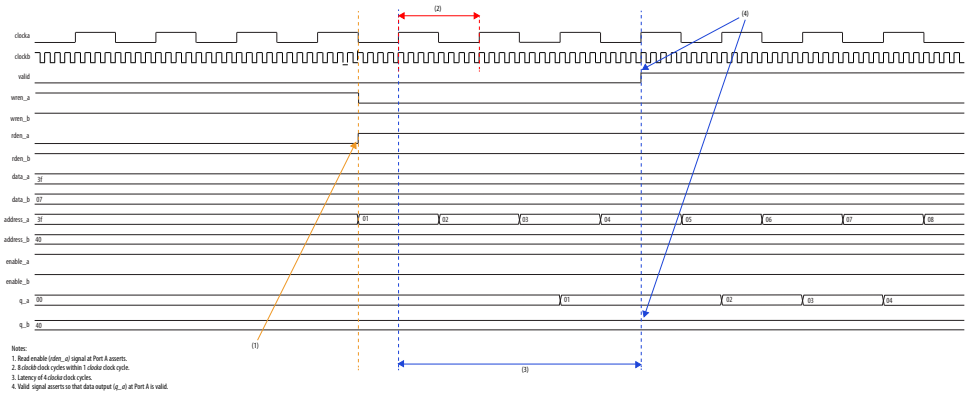
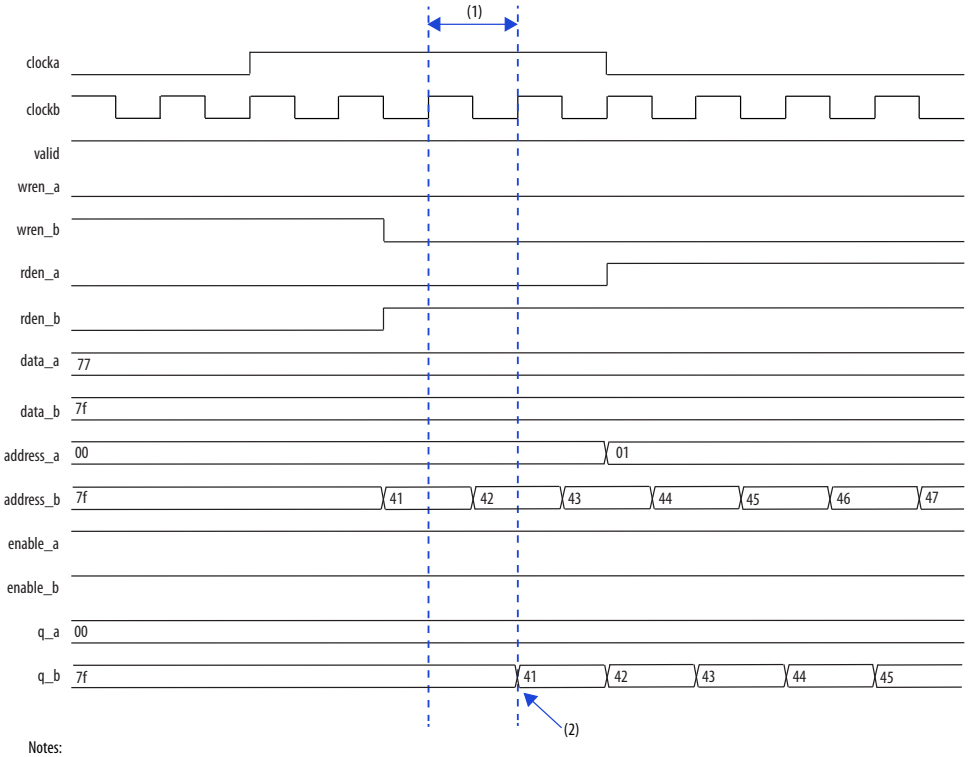
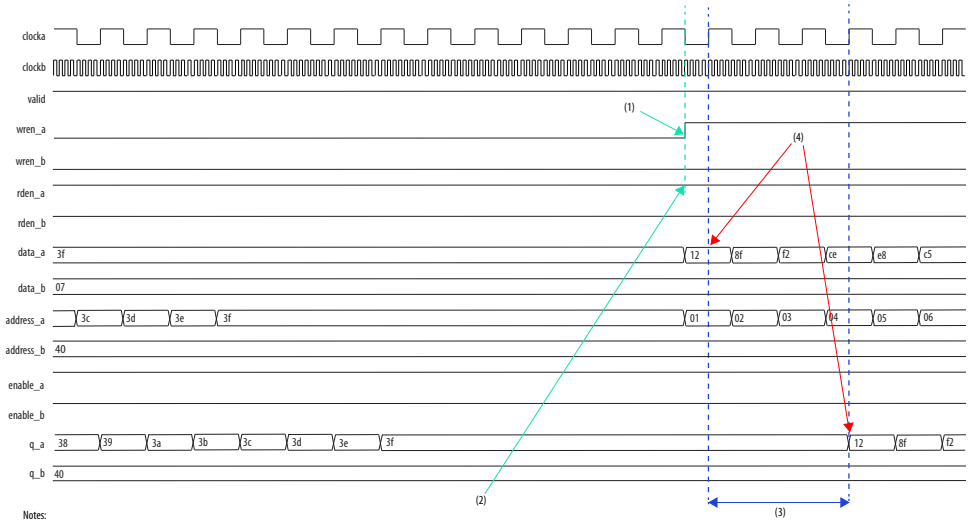


Figure 15. Output Condition of Port B



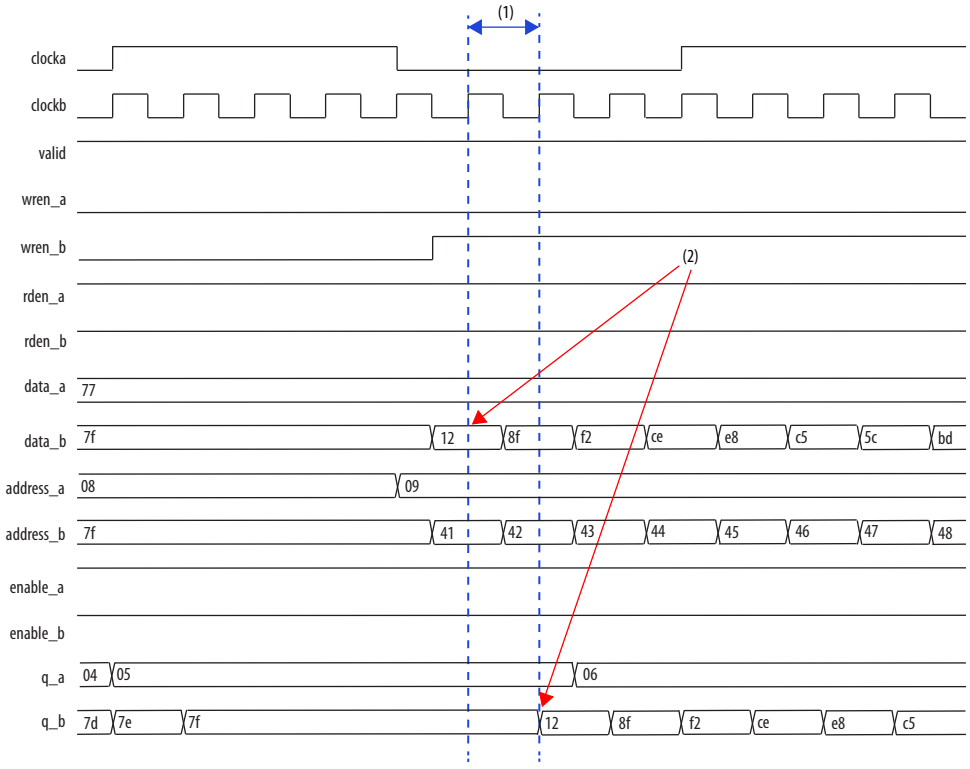
Notes:
1. Latency of 2 *clockb* clock cycles.
2. Valid data output (*q_b*) at Port B.

Figure 16. Read-During-Write Condition of Port A



Notes:
1. Write enable (*wren_a*) signal at Port A asserts.
2. Read enable signal (*rden_a*) signal at Port A is already high.
3. Latency of 4 *clocka* clock cycles.
4. Port A same port RDW occurs and the flow through value appears as data output (*q_a*) at Port A after 4 *clocka* clock cycles.

Figure 17. Read-During-Write Condition of Port B



Notes:
1. Latency of 2 *clockb* clock cycles.
2. Port B same port RDW occurs and the flow through value appears as data output (*q_b*) at Port B after 2 *clockb* clock cycles.

3. Intel Stratix 10 Embedded Memory Design Considerations

There are several considerations that require your attention to ensure the success of your Intel Stratix 10 designs.

Note: Unless noted otherwise, these considerations apply to all variants of the Intel Stratix 10 device family.

3.1. Consider the Memory Block Selection

The Intel Quartus Prime software automatically partitions user-defined memory into the embedded memory blocks based on your design's speed and size constraints. For example, the Intel Quartus Prime software may spread out the memory across multiple available memory blocks to increase the performance of your design.

To assign the memory to a specific block size manually, use the parameter editor of the On-Chip Memory IP cores.

For the MLABs, you can implement single-port SRAM through emulation using the Intel Quartus Prime software. Emulation minimizes additional use of logic resources.

Because of the dual purpose architecture of the MLAB, the block has only data input registers, output registers, and write address registers. The MLABs gain read address registers from the ALMs.

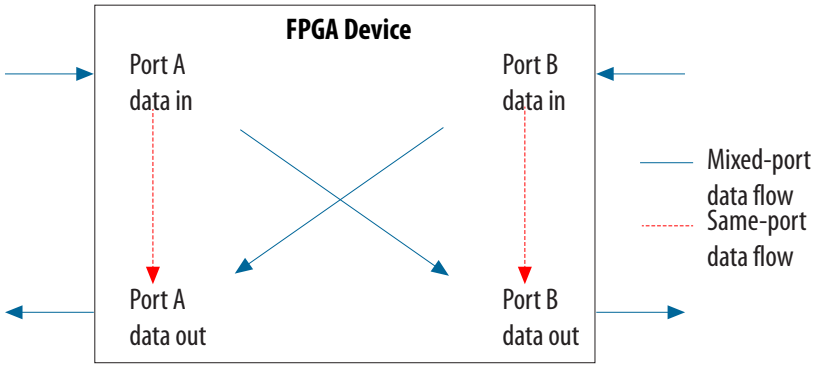
Note: For Intel Stratix 10 devices, the Resource Property Editor and the Timing Analyzer report the location of the M20K block as *EC_X<number>_Y<number>_N<number>*, even though the assigned location allowed is *M20K_X<number>_Y<number>_N<number>*. Embedded Cell (EC) is the sub-location of the M20K block.

3.2. Customize Read-During-Write Behavior

Customize the read-during-write behavior of the memory blocks to suit your design requirements.

Figure 18. Read-During-Write Data Flow

This figure shows the difference between the two types of read-during-write operations available: same port and mixed port.



3.2.1. Same-Port Read-During-Write Mode

The same-port read-during-write mode applies to a single-port RAM, simple quad-port RAM or the same port of a true dual-port RAM.

Table 15. Output Modes for Embedded Memory Blocks in Same-Port Read-During-Write Mode

This table lists the available output modes if you select the embedded memory blocks in the same-port read-during-write mode.

Output Mode	Memory Type	Description
New Data	M20K	The new data is available on the rising edge of the same clock cycle on which the new data is written.
Don't Care	M20K, MLAB	The RAM produces *Don't Care* values for a read-during-write operation. *Note:* For QUAD_PORT operating mode, the *Don't Care* mode is the only output mode for a same port read-during-write-operation.

Figure 19. Same-Port Read-During-Write: New Data Mode

This figure shows sample functional waveforms of same-port read-during-write behavior in the *New Data* mode.

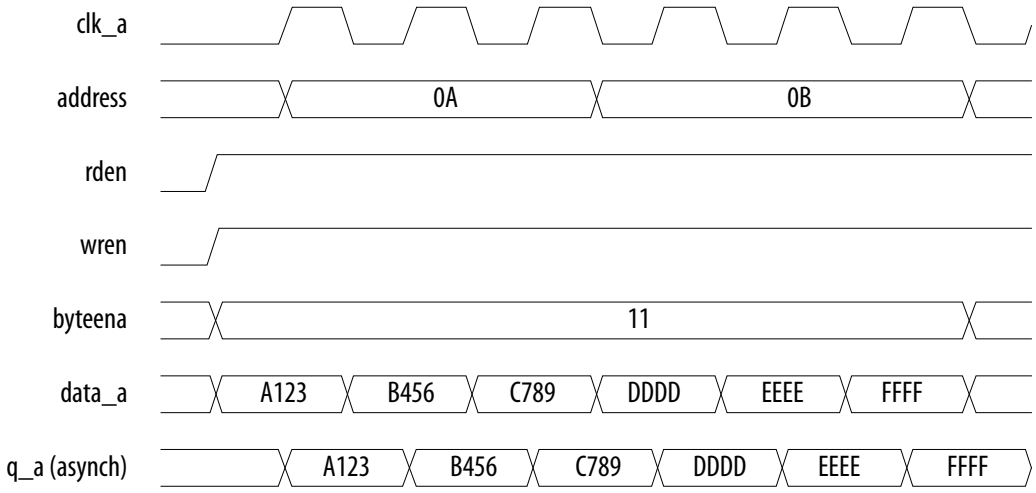
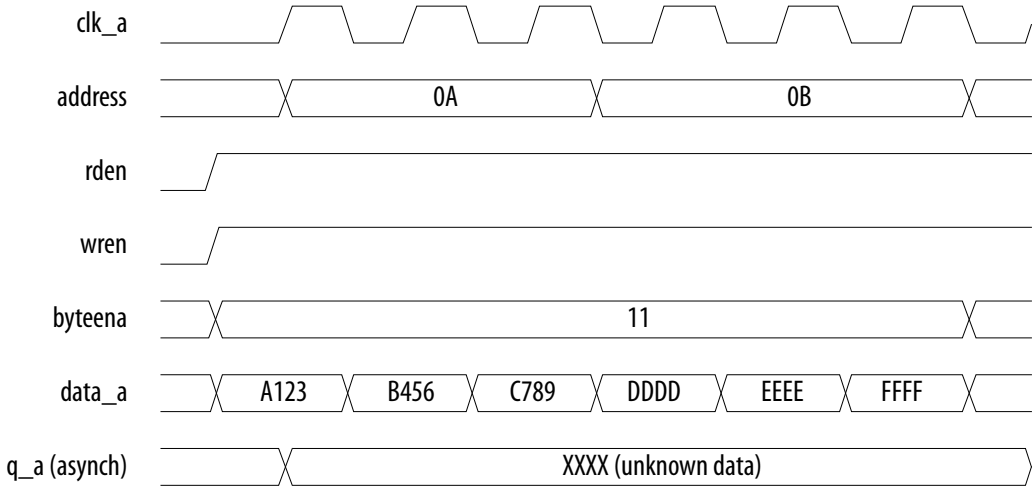


Figure 20. Same-Port Read-During-Write: Don't Care Mode

This figure shows sample functional waveforms of same-port read-during-write behavior in the *Don't Care* mode.



3.2.2. Mixed-Port Read-During-Write Mode

The mixed-port read-during-write mode applies to simple dual-port RAM mode. Two ports perform read and write operations on the same memory address using the same clock: one port reading from the address, and the other port writing to it.

Table 16. Output Modes for RAM in Mixed-Port Read-During-Write Mode

Output Mode	Memory Type	Description
New Data	MLAB	A read-during-write operation to different ports causes the MLAB registered output to reflect the *New Data* on the next rising edge after the data is written to the MLAB memory.

continued...

Output Mode	Memory Type	Description
		This mode is available only if the output is registered.
Old Data	M20K, MLAB	A read-during-write operation to different ports causes the RAM output to reflect the *Old Data* value at that particular address. For MLAB, this mode is available only if the output is registered.
Don't Care	M20K, MLAB	The RAM produces *Don't Care* or *Unknown* value. • For M20K, the Intel Quartus Prime software does not analyze the timing between write and read operations. • For MLAB, the Intel Quartus Prime software does not analyze the timing between write and read operations by default. To enable this behavior: — Turn off the **Do not analyze the timing between write and read operation. Metastability issues are prevented by never writing and reading at the same address at the same time** option in the embedded memory IP core parameter editor. or — Turn on the **MLAB Add Timing Constraints For Mixed-Port Feed-Through Mode Setting Don't Care** option in the **Advanced Fitter Setting**. *Note:* In M20K's true dual port operation, you will experience getting new data value during the mix-port read-during-write mode in simulation. When you set the output mode as *Don't Care*, the simulation value should treat it as a junk value.
New_a_old_b	M20K	This mode applicable only in simple-quad port for M20K where the read-during-write operation to different ports causes the RAM output to reflect new data at port A and old data at port B.

Table 17. Mixed Port Read-During-Write Output Behaviors

This table lists and describes the output behaviors of the mixed-port read-during-write mode. These behaviors are applicable only for MLAB blocks.

RAM: 2-PORT Intel FPGA IP Settings		Output Behavior		
Parameter	**Enabled Parameter Options**	**altera_syncram Parameter (read_during_write_mode_mixed_ports)**	**Output Data when Read-During-Write**	**MLAB Atom (visible in Chip Planner)**
Mixed Port Read-During-Write for Single Input Clock RAM	Old memory contents appear	`old_data`	Old data (4)	New Data
	New data	`new_data`	New data	New Data
	I do not care (The outputs will be undefined)	`constrained_dont_care`	New data	Constrained Don't Care

continued...

(4) Old data is achieved through external soft logic as the MLAB blocks only natively supports new data.

RAM: 2-PORT Intel FPGA IP Settings		Output Behavior		
Parameter	**Enabled Parameter Options**	**altera_syncram Parameter (`read_during_write_mode_mixed_ports`)**	**Output Data when Read-During-Write**	**MLAB Atom (visible in Chip Planner)**
How should the q_a and q_b outputs behave when reading a memory location that is being written from the other ports?	• I do not care (The outputs will be undefined) • Do not analyze the timing between write and read operation. Metastability issues are prevented by never writing and reading at the same address at the same time.	`dont_care`	New data	Don't Care

Figure 21. Mixed-Port Read-During-Write: *New Data* Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the *New Data* mode.

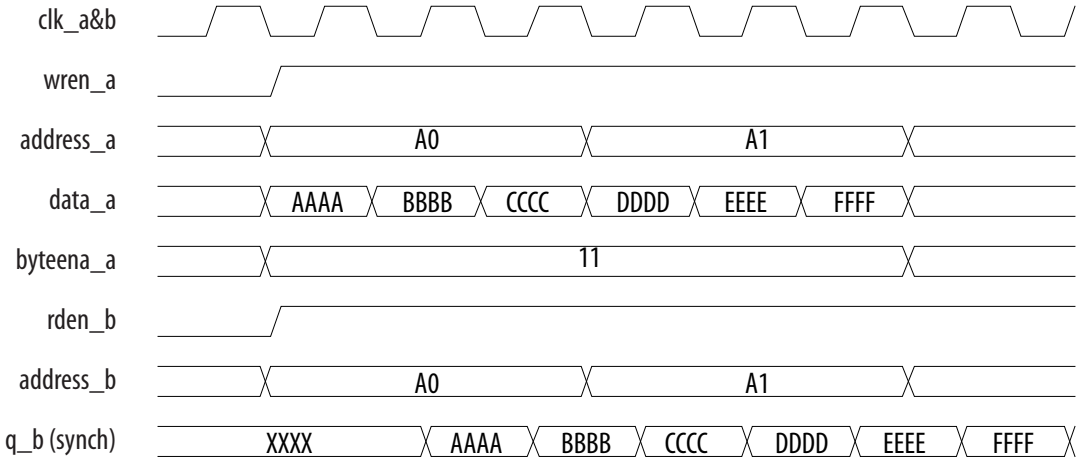


Figure 22. Mixed-Port Read-During-Write: *Old Data* Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the *Old Data* mode.

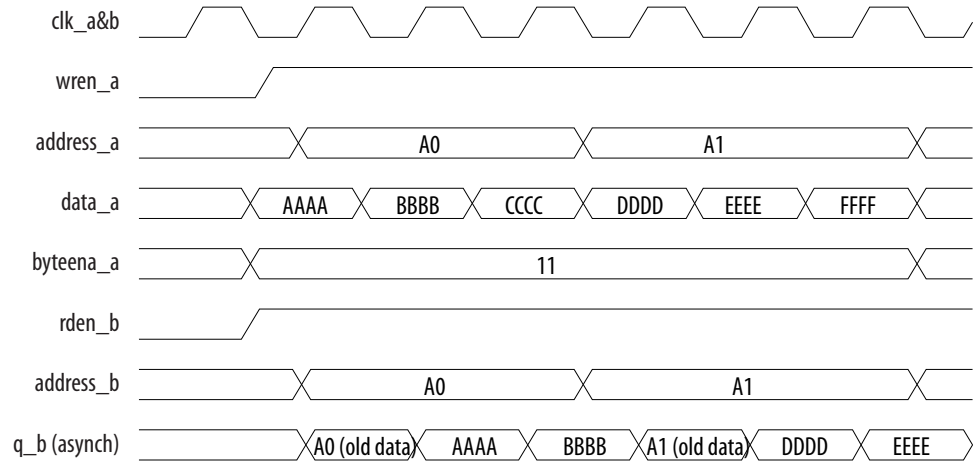


Figure 23. Mixed-Port Read-During-Write: *Don't Care* Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the *Don't Care* mode. This behavior is only applicable for M20K blocks.

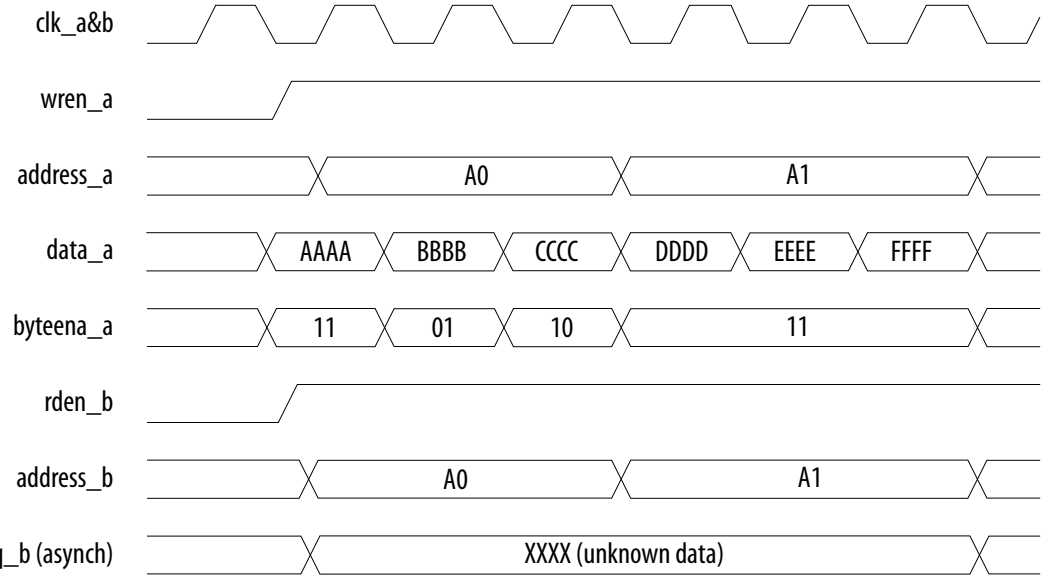
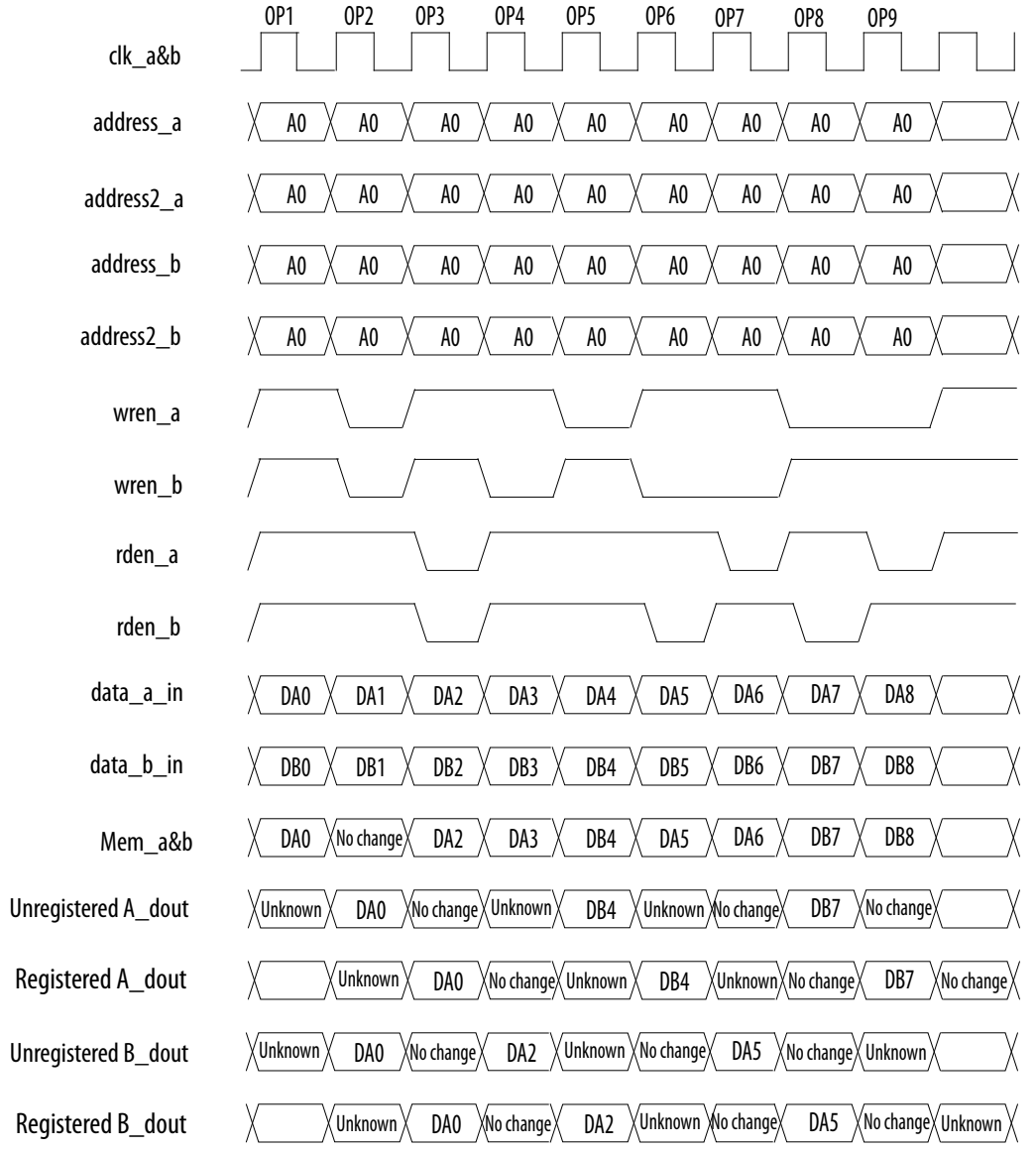


Figure 24. Mixed-Port Read-During-Write: *New_a_old_b* Mode

This figure shows a sample functional waveform of mixed-port read-during-write behavior for the *New_a_old_b* mode.



Notes:

1. When the same-port read-during-write and mixed-port read-during-write behaviors exist simultaneously (OP1), the single quad-port will honor the same-port read-during-write behavior.
2. When the same-port read-during-write behavior happens, the output should be unknown.

3.3. Consider Power-Up State and Memory Initialization

Consider the power-up state of the different types of memory blocks if your design logic evaluates the initial power-up values.

Table 18. Initial Power-Up Values of Embedded Memory Blocks

Memory Type	Output Registers	Power-Up Value
MLAB	Used	Zero (cleared)
	Bypassed	Read memory contents
M20K	Used	Zero (cleared)
	Bypassed	Zero (cleared)

By default, the Intel Quartus Prime software initializes the embedded memory block in Intel Stratix 10 devices to zero, unless you specify in the memory contents in a `.mif`.

The MLAB and M20K embedded memory blocks support initialization with a `.mif`. You can create `.mif` files in the Intel Quartus Prime software and specify their use with the on-chip memory IP core when you create an instance of a memory in your design. Even if a memory is pre-initialized (for example, using a `.mif`), the memory still powers up with its output cleared.

3.4. Reduce Power Consumption

Reduce alternating current (AC) power consumption of each memory block in your design.

- Use the Intel Stratix 10 memory block clock enables to control the clocking of each embedded memory block.
- Use the read enable signal to ensure that read operations occur only when necessary. If your design does not require read-during-write, you can reduce power consumption by deasserting the read enable signal during write operations and when there are no memory operations.
- Use the Intel Quartus Prime software to automatically place any unused embedded memory blocks in low-power mode to reduce static power.

4. Intel Stratix 10 Embedded Memory IP Core References

You can access the features of the Intel Stratix 10 Embedded Memory using the On Chip Memory IP cores in the Intel Quartus Prime software.

The On Chip Memory IP cores include:

- RAM: 1-Port Intel FPGA IP—instantiates the single-port RAM
- RAM: 2-Port Intel FPGA IP—instantiates the dual-port and bidirectional-port RAM
- RAM: 4-Port Intel FPGA IP—instantiates the quad-port RAM
- ROM: 1-Port Intel FPGA IP—instantiates the single-port ROM
- ROM: 2-Port Intel FPGA IP—instantiates the dual-port and bidirectional-port ROM
- eSRAM (Embedded Synchronous Random Access Memory)Intel FPGA IPe—instantiates the native eSRAM block
- FIFO (First-In-First-Out) Intel FPGA IP—instantiates the FIFO Intel FPGA IP core
- FIFO2 Intel FPGA IP—instantiates the FIFO2 Intel FPGA IP core

The information for each IP core parameter is described in the parameter editors in the Intel Quartus Prime software.

Related Information

- Introduction to Intel IP Cores
  Provides general information about all Intel FPGA IP cores, including parameterizing, generating, upgrading, and simulating IP cores.
- Creating Version-Independent IP and Qsys Simulation Scripts
  Create simulation scripts that do not require manual updates for software or IP version upgrades.
- Project Management Best Practices
  Guidelines for efficient management and portability of your project and IP files.

4.1. On Chip Memory RAM and ROM Intel FPGA IP Cores

Table 19.

On Chip Memory Intel FPGA IP Cores	Features
RAM: 1-PORT Intel FPGA IP	• Non-simultaneous read and write operations from a single address. • Read enable port to specify the behavior of the RAM output ports during a write operation, to overwrite or retain existing value. • Emulates single-port ROM using DUAL_PORT configuration for block RAM.
RAM: 2-PORT Intel FPGA IP	Simple dual-port RAM • Simultaneous one read and one write operations to different locations. • Supports error correction code (ECC). • Emulates single-port RAM using DUAL_PORT configuration for block RAM.
	True dual-port RAM • Simultaneous two reads. • Simultaneous two writes. • Simultaneous one read and one write at two different clock frequencies. • Emulates dual-port ROM using BIDIR_DUAL_PORT configuration for block RAM.
RAM: 4-PORT Intel FPGA IP	• Simultaneous two reads and two writes to different locations.
ROM: 1-PORT Intel FPGA IP	• One port for read-only operations.
ROM: 2-PORT Intel FPGA IP	• Two ports for read-only operations.

4.1.1. Changing Parameter Settings Manually

When the IP core has been generated using the IP Parameter Editor, you can use this flow to change of the parameter settings within the specified memory mode. However, to change the memory mode, use the IP Parameter Editor to configure and regenerate the IP core.

Follow these steps to change the parameter settings manually:

1. Locate the Verilog design file: *<project directory>*/*<project name_software version>*/synth/*<project name_rtl>*.v.
2. Change the parameter settings in the design file. Ensure that you use only legal parameter values as specified in Parameters and Signals topic. Failing to do so results in compilation errors.
3. Compile the design using the Intel Quartus Prime software.

For example, the following codes enable the ECC feature and specify the initialization file.

```
altera_syncram_component.enable_ecc = "TRUE",
altera_syncram_component.ecc_pipeline_stage_enabled = "FALSE",
altera_syncram_component.init_file = "mif1.mif",
```

To disable the ECC feature and specify a different .mif file, make the following changes.

```
altera_syncram_component.enable_ecc = "FALSE",
altera_syncram_component.ecc_pipeline_stage_enabled = "FALSE",
altera_syncram_component.init_file = "mif2.mif",
```

4.1.2. RAM and ROM Parameter Settings

Table 20. Parameters for altera_syncram

Use the parameter list when editing the design file manually.

Name	Legal Values	Description
operation_mode	**SINGLE_PORT** **DUAL_PORT** **BIDIR_DUAL_PORT** **QUAD_PORT** **ROM**	Operation mode of the memory block.
width_a	—	Data width of port A.
widthad_a	—	Address width of port A.
widthad2_a		Address 2 width of port A.
numwords_a	—	Number of data words in the memory block for port A.
outdata_reg_a	**UNREGISTERED** **CLOCK1** **CLOCK0**	Clock for the data output registers of port A.
outdata_aclr_a	**NONE** **CLEAR1** **CLEAR0**	Asynchronous clear for data output registers of port A. When the `outdata_reg_a` parameter is set to **UNREGISTERED**, this parameter specifies the clearing parameter for the output latch.
outdata_sclr_a	**NONE** **SCLEAR**	Synchronous clear for data output registers of port A. When the `outdata_reg_a` parameter is set to **NONE**, this parameter specifies the clearing parameter for the output latch.
width_byteena_a	—	Width of the byte-enable bus of port A. The width must be equal to the value of `width_a` divided by the byte size. The default value of 1 is only allowed when byte-enable is not used.
width_b	—	Data width of port B.
widthad_b	—	Address width of port B.
widthad2_b	—	Address 2 width of port B.
numwords_b	—	Number of data words in the memory block for port B.
outdata_reg_b	**UNREGISTERED** **CLOCK1** **CLOCK0**	Clock for the data output registers of port B.
indata_reg_b	**CLOCK1** **CLOCK0**	Clock for the data input registers of port B.
address_reg_b	**CLOCK1** **CLOCK0**	Clock for the address registers of port B.
byteena_reg_b	**CLOCK1** **CLOCK0**	Clock for the byte-enable registers of port B.

continued...

Name	Legal Values	Description
outdata_aclr_b	**NONE** **CLEAR1** **CLEAR0**	Asynchronous clear for data output registers of port B. When the outdata_reg_b parameter is set to **UNREGISTERED**, this parameter specifies the clearing parameter for the output latch.
outdata_sclr_b	**NONE** **SCLEAR**	Synchronous clear for data output registers of port B. When the outdata_reg_b parameter is set to **NONE**, this parameter specifies the clearing parameter for the output latch.
width_byteena_b	—	Width of the byte-enable bus of port B. The width must be equal to the value of width_b divided by the byte size. The default value of 1 is only allowed when byte-enable is not used.
ram_block_type	**M20K** **MLAB** **AUTO**	The memory block type.
byte_size	**5** **8** **9** **10**	The byte size for the byte-enable mode.
read_during_write_mode_mixed_ports	**DONT_CARE** **CONSTRAINT_DONT_CARE** **NEW_DATA** **OLD_DATA** **NEW_A_OLD_B**	The behavior for the read-during-write mode. • The default value is **DONT_CARE**. • The value of **NEW_DATA** is supported only when the read address and output data are registered by the write clock in the LUTRAM mode. • The value of **CONSTRAINED_DONT_CARE** is supported only in the LUTRAM mode. • The value of **NEW_A_OLD_B** is supported only when the operation_mode parameter is set to **QUAD_PORT**.
init_file	*.mif *.hex	The initialization file.
init_file_layout	**PORT_A** **PORT_B**	The layout of the initialization file.
maximum_depth	—	The depth of the memory block slices.
clock_enable_input_a	**NORMAL** **BYPASS**	The clock enable for the input registers of port A.
clock_enable_output_a	**NORMAL** **BYPASS**	The clock enable for the output registers of port A.
clock_enable_input_b	**NORMAL** **BYPASS**	The clock enable for the input registers of port B.
clock_enable_output_b	**NORMAL** **BYPASS**	The clock enable for the output registers of port B.
read_during_write_mode_port_a	**NEW_DATA_NO_NBE_READ** **NEW_DATA_WITH_NBE_READ** **OLD_DATA** **DONT_CARE**	The read-during-write behavior for port A.
read_during_write_mode_port_b	**NEW_DATA_NO_NBE_READ**	The read-during-write behavior for port B.

continued...

Name	Legal Values	Description
	NEW_DATA_WITH_NBE_READ **OLD_DATA** **DONT_CARE**	
`enable_ecc`	**TRUE** **FALSE**	Enables or disables the ECC feature.
`ecc_pipeline_stage_enabled`	**TRUE** **FALSE**	• Specifies whether to enable ECC Pipeline Registers before the output decoder to achieve the same performance as non-ECC mode at the expense of one cycle of latency. • The parameter `enable_ecc` must set to **TRUE** if this parameter is set to **TRUE**. • The parameter `outdata_reg_b` cannot set to UNREGISTERED if this parameter is set to **TRUE**. • The default value is **FALSE**.
`enable_coherent_read`	**TRUE** **FALSE**	Enables or disables the coherent read feature. • The default value is **FALSE**.
`enable_force_to_zero`	**TRUE** **FALSE**	Enables or disables the Force-to-Zero feature. • The default value is **FALSE**.
`width_eccencparity`	**8**	The width of the `eccencparity` signal.

4.1.3. RAM: 1-PORT Intel FPGA IP Parameters

This table lists the parameters for the RAM: 1-PORT Intel FPGA IP core.

Table 21. RAM: 1-PORT Intel FPGA IP Parameters Description

Parameter	Legal Values	Description
Parameter Settings: Widths/Blk Type/Clks		
How wide should the 'q' output bus be?	—	Specifies the width of the 'q' output bus.
How many words of memory?	—	Specifies the number of bit words.
What should the memory block type be?	Auto, MLAB, M20K, LCs	Specifies the memory block type. The types of memory block that are available for selection depends on your target device.
Set the maximum block depth to	• MLAB: Auto, 32 • M20K: Auto, 512, 1024, 2048 • LCs: Auto	Specifies the maximum block depth in words.
How should the memory be implemented?	• Use default logic cell style • Use Stratix M512 emulation logic cell style	Specifies the logic cell implementation method. • Select **Use default logic cell style** if you prefer smaller and faster memory capacity. • Select **Use Stratix M512 emulation logic cell style** if you prefer the memory to be compatible to the Stratix M512 emulation style.

continued...

Parameter		Legal Values	Description
What clocking method would you like to use?		• Single clock • Dual clock: use separate 'input' and 'output' clocks	Specifies the clocking method to use. • **Single clock**—A single clock and a clock enable controls all registers of the memory block. • **Dual clock: use separate 'input' and 'output' clocks**—An input and an output clock controls all registers related to the data input and output to/from the memory block including data, address, byte enables, read enables, and write enables.
Parameter Settings: Regs/Clken/Byte Enable/Aclrs			
Which ports should be registered? The following options are available: • 'data' and 'wren' input ports • 'address' input port • 'q' output port		On/Off	Specifies whether to register the input and output ports.
Create one clock enable signal for each clock signal. *Note:* All registered ports are controlled by the enable signal(s).		On/Off	Specifies whether to turn on the option to create one clock enable signal for each clock signal.
More Options	Use clock enable for port A input registers	On/Off	Specifies whether to use clock enable for port A input registers.
	Use clock enable for port A output registers	On/Off	Specifies whether to use clock enable for port A output registers.
	Create an 'addressstall_a' input port.	On/Off	Specifies whether to create an `addressstall_a` input port. You can create this port to act as an extra active low clock enable input for the address registers.
Create byte enable for port A		On/Off	Specifies whether to create a byte enable for port A. Turn on this option if you want to mask the input data so that only specific bytes, nibbles, or bits of data are written. To enable byte enable for port A and port B, the data width ratio has to be 1 or 2 for the RAM: 1-PORT and RAM: 2-PORT Intel FPGA IP cores.
What is the width of a byte for byte enables?		• MLAB: 5 or 10 • Other memory block types: 8 or 9 • M20K: 8, 9, or 10	Specifies the byte width of the byte enable port. The width of the data input port must be divisible by the byte size.
Create an 'aclr' asynchronous clear for the registered ports. • 'data' port • 'wren' port • 'address' port • 'q' port • 'byteena_a' port		On/Off	Turn on if you want the registered 'data', 'wren', 'address', 'q', and 'byteena_a' ports to be affected by the asynchronous clear signal. The disabled ports are not affected by the asynchronous clear signal.
Create an 'sclr' synchronous clear for the registered port. 'q' port		On/Off	Turn on if you want the 'q' port to be affected by the synchronous clear signal.

continued...

Parameter	Legal Values	Description
Create a 'rden' read enable signal	On/Off	Turn on if you want to create a read enable signal.
Parameter Settings: Read During Write Option		
What should the 'q' output be when reading from a memory location being written to?	Don't Care, New Data	Specifies the output behavior when read-during-write occurs. **Don't Care**—The RAM outputs "don't care" or "unknown" values for read-during-write operation. **New Data**—New data is available on the rising edge of the same clock cycle on which it was written.
Get x's for write masked bytes instead of old data when byte enable is used	On/Off	Turn on this option to obtain 'X' on the masked byte. For M20K memory blocks, this option is not available if you specify **New Data** as the output behavior when RDW occurs.
Parameter Settings: Mem Init		
Do you want to specify the initial content of the memory?	• No, leave it blank • Yes, use this file for the memory content data	Specifies the initial content of the memory. To initialize the memory to zero, select **No, leave it blank**. To use a memory initialization file (`.mif`) or a hexadecimal (Intel-format) file (`.hex`), select **Yes, use this file for the memory content data.**
Initialize memory content data to XX..X on power-up in simulation	On/Off	—
Implement clock-enable circuitry for use in a partial reconfiguration region	On/Off	Specifies whether to implement clock-enable circuitry for use in a partial reconfiguration region.
Allow In-System Memory Content Editor to capture and update content independently of the system clock	On/Off	Specifies whether to allow In-System Memory Content Editor to capture and update content independently of the system clock.
The 'Instance ID' of this RAM is	NONE	Specifies the RAM ID.
Parameter Settings: Performance Optimization		
Enable Force To Zero	On/Off	Specifies whether to set the output to zero when you deassert the read enable signal. Enabling this feature helps improve the glue logic performance when the selected memory depth is larger than a single memory block.

4.1.4. RAM: 2-PORT Intel FPGA IP Parameters

This table lists the parameters for the RAM: 2-PORT Intel FPGA IP core.

Table 22. RAM: 2-PORT Intel FPGA IP Parameter Settings

Parameter	Legal Values	Description
Parameter Settings: General		
How will you be using the dual port RAM?	Operation mode: • With one read port and one write port • With two read /write ports	Specifies how you use the dual port RAM.

continued...

Parameter	Legal Values	Description
How do you want to specify the memory size?	Type: • As a number of words • As a number of bits	Determines whether to specify the memory size in words or bits.
Parameter Settings: Widths/ Blk Type		
How many words of memory?	—	Specifies the number of words.
Use different data widths on different ports	On/Off	Specifies whether to use different data widths on different ports.
When you select **With one read port and one write port** or **With two read/write ports**, the following options are available: • How wide should the 'q_a' output bus be? • How wide should the 'data_a' input bus be? • How wide should the 'q_b' output bus be?	—	Specifies the width of the input and output ports.
Ram block type	Auto, MLAB, M20K, LCs	Specifies the memory block type. The types of memory block that are available for selection depends on your target device.
Set the maximum block depth to	• MLAB: Auto, 32 • M20K: Auto, 512, 1024, 2048 • LCs: Auto	Specifies the maximum block depth in words. • MLAB: Auto, 32 • M20K: Auto, 512, 1024, 2048 • LCs: Auto
How should the memory be implemented?	• Use default logic cell style • Use Stratix M512 emulation logic cell style	Specifies the logic cell implementation method. • Select default logic cell style if you prefer smaller and faster memory capacity. • Select Stratix M512 emulation logic cell style if you prefer the memory to be compatible to the Stratix M512 emulation style. *Note:* This option is applicable only when you choose LCs memory type.
Parameter Settings: Clks/Rd, Byte En		
What clocking method would you like to use?	• Single clock • Dual clock: use separate 'input' and 'output' clocks • Dual clock: use separate 'read' and 'write' clocks • No clock (fully asynchronous) • Customize clocks for A and B ports	Specifies the clocking method to use.

continued...

Parameter	Legal Values	Description
		• **Single clock**—A single clock and a clock enable controls all registers of the memory block. • **Dual Clock: use separate 'input' and 'output' clocks**—An input and an output clock controls all registers related to the data input and output to/from the memory block including data, address, byte enables, read enables, and write enables. • **Dual clock: use separate 'read' and 'write' clock**—A write clock controls the data-input, write-address, and write-enable registers while the read clock controls the data-output, read-address, and read-enable registers. • **Dual clock: use separate clocks for A and B ports**—Clock A controls all registers on the port A side; clock B controls all registers on the port B side. Each port also supports independent clock enables for both port A and port B registers, respectively. • **No clock (fully asynchronous)**— • **Customize clocks for A and B ports**—
When you select **With two read/ write ports** and **Customize clocks for A and B ports** clocking method, the following option is available: Emulate TDP dual clock mode	—	Specifies whether to emulate a TDP dual clock mode. The clock connection to Port A must be a slow clock and the clock connection to Port B must be a fast clock.
When you select **With one read port and one write port**, the following option is available: Create a 'rden' read enable signal	—	Specifies whether to create a read enable signal for port B.
When you select **With two read/ write ports**, the following option is available: Create a 'rden_a' and 'rden_b' read enable signals		Specifies whether to create a read enable signal for port A and B.
Create byte enable for port A	—	Specifies whether to create a byte enable for port A and B. Turn on these options if you want to mask the input data so that only specific bytes, nibbles, or bits of data are written. To enable byte enable for port A and port B, the data width ratio has to be 1 or 2 for the RAM: 1-PORT and RAM: 2-PORT Intel FPGA IP cores. The option to create a byte enable for port B is only available when you select the **With two read/write ports** option.
Create byte enable for port B	—	
What is the width of a byte for byte enables?	• MLAB: 5 or 10 • Other memory block types: 8 or 9 • M20K: 8, 9, or 10	Specifies the width of a byte for byte enables.

continued...

Parameter	Legal Values	Description
		This option is only available you select the **Create byte enable for port A** and/or **Create byte enable for port B** option(s).
Enable Error Correction Check (ECC)	On/Off	Specifies whether to enable the ECC feature that corrects single bit errors, double adjacent bit errors, and detects triple adjacent bit errors at the output of the memory.
Enable ECC Pipeline Registers	On/Off	Specifies whether to enable the ECC Pipeline Registers before the output decoder to achieve that same performance as non-ECC mode at the expense of one cycle of latency.
Enable ECC Encoder Bypass	On/Off	Specifies whether to enable the ECC encoder bypass feature that allows yu to selectively insert parity bits into the memory through eccencparity port.
Enable Coherent Read	On/Off	Specifies whether to enable the coherent read feature to present with coherent memory read. This feature allows you to read out current memory content, perform operation on top of the content, and write back to the same location in the same cycle.
Parameter Settings: Regs/Clkens/Aclrs		
Which ports should be registered? When you select **With one read port and one write port**, the following options are available: • All write input ports • raddress port • q_b port When you select **With two read/ write ports**, the following options are available: • All write input ports • raddress port • q_a port • q_b port	On/Off	Specifies whether to register the read or write input and output ports.
Clock Enables When you select **With one read port and one write port**, the following option is available: • Use different clock enables for registers • Use clock enable for write input registers • Use clock enable for read input registers • Use clock enable for output registers	On/Off	Specifies whether to create clock enables for read and write registers.

continued...

Parameter	Legal Values	Description
When you select **With two read / write ports**, the following options are available: • Use different clock enables for registers • Use clock enable for port A input registers • Use clock enable for port A output registers • Use clock enable for port B input registers • Use clock enable for port B output registers		
Addressstalls When you select **With one read port and one write port**, the following option is available: • Create a 'addressstall_a' input port.	On/Off	Specifies whether to create clock enables for address registers. You can create these ports to act as an extra active low clock enable input for the address registers.
Aclr Options When you select **With one read port and one write port**, the following options are available: • rdaddress port • q_b port When you select **With two read / write ports**, the following options are available: • q_a port • q_b port	On/Off	Specifies whether to create an asynchronous clear port for the registered ports. Specifies whether the 'raddress', 'q_a', and 'q_b' ports are cleared by the aclr port.
Sclr Options When you select **With one read port and one write port**, the following options are available: • q_b port When you select **With two read / write ports**, the following options are available: • q_a port • q_b port	On/Off	Specifies whether to create a synchronous clear port for the registered ports. Specifies whether the 'q_a', and 'q_b' ports are cleared by the sclr port.
Parameter Settings: Output 1 (This tab is only available when you select one read port and one write ports)		
continued...		

Parameter	Legal Values	Description
How should the q_a and q_b outputs behave when reading a memory location that is being written from the other port?	• New Data • Old memory contents appear • I do not care (The outputs will be undefined)	Specifies the output behavior when read-during-write occurs. • **New Data**—New data is available on the rising edge of the same clock cycle on which it was written. • **Old memory contents appear**—The RAM outputs reflect the old data at that address before the write operation proceeds. • **I do not care**—This option functions differently when you turn it on depending on the following memory block type you select: — When you set the memory block type to **Auto**, **M20K**, or any other block RAM, the RAM outputs 'don't care' or "unknown" values for read-during-write operation without analyzing the timing path. — When you set the memory block type to **MLAB** (for LUTRAM), the RAM outputs 'don't care' or 'unknown' values for read-during-write operation but analyzes the timing path to prevent metastability.
Do not analyze the timing between write and read operation. Metastability issues are prevented by never writing and reading at the same address at the same time.	On/Off	Turn on this option when you want the RAM to output 'don't care' or unknown values for read-during-write operation without analyzing the timing path. This option is only available for LUTRAM and is enabled when you set memory block type to **MLAB.**
Parameter Settings: Output 2 (This tab is only available when you select two read/ write ports)		
What should the 'q_a' output be when reading from a memory location being written to?	• New data • Old Data	Specifies the output behavior when read-during-write occurs. • **New Data**—New data is available on the rising edge of the same clock cycle on which it was written. • **Old Data**—The RAM outputs reflect the old data at that address before the write operation proceeds.
What should the 'q_b' output be when reading from a memory location being written to?		
Get x's for write masked bytes instead of old data when byte enable is used	On/Off	Turn on this option to obtain 'X' on the masked byte.
Parameter Settings: Mem Init		
Do you want to specify the initial content of the memory?	• No, leave it blank • Yes, use this file for the memory content data	Specifies the initial content of the memory. To initialize the memory to zero, select **No, leave it blank.** To use a memory initialization file (**.mif**) or a hexadecimal (Intel-format) file (**.hex**), select **Yes, use this file for the memory content data**.
Initialize memory content data to XX..X on power-up in simulation	On/Off	—

continued...

Parameter	Legal Values	Description
The initial content file should conform to which port's dimensions?	PORT_A, PORT_B	If you select to use the initial content file for memory content data, select the port the file should conform to.
Implement clock-enable circuitry for use in a partial reconfiguration region	On/Off	Specifies whether to implement clock-enable circuitry for use in a partial reconfiguration region.Implement clock-enable circuitry for use in a partial reconfiguration region
Parameter Settings: Performance Optimization		
Enable Force to Zero	On/Off	Specifies whether to set the output to zero when you deassert the read enable signal. Enabling this feature helps improve the glue logic performance when the selected memory depth is larger than a single memory block.

4.1.5. RAM: 4-PORT Intel FPGA IP Parameters

This table lists the parameters for the RAM: 4-PORT Intel FPGA IP core.

Table 23. RAM: 4-PORT Intel FPGA IP Parameter Settings

Parameter	Legal Values	Description
Parameter Settings: Widths/ Blk Type		
How many words of memory?	—	Specifies the number of bit words.
How wide should the 'q_a' and 'q_b' output bus be?	—	Specifies the width of the input and output ports.
RAM block type	Auto, M20K	Specifies the memory block type. The types of memory block that are available for selection depends on your target device.
Set the maximum block depth to	M20K: Auto, 512, 1024, 2048	Specifies the maximum block depth in words.
Parameter Settings: Clks/Rd, Byte En		
What clocking method would you like to use?	Single clock	Specifies the clocking method to use. **Single clock**—A single clock and a clock enable controls all registers of the memory block.
Create 'rden_a' and 'rden_b' read enable signals	—	Specifies whether to create a read enable signal for ports A and B.
What is the width of a byte for byte enables?	M20K: 8, 9, 10	Specifies the byte width of the byte enable port. The width of the data input port must be divisible by the byte size.
Parameter Settings: Regs/Clkens/Aclrs		

continued...

Parameter	Legal Values	Description
Which ports should be registered? Input registers: • All write input ports • 'raddress' port Output registers: • 'q_a' port • 'q_b' port	On/Off	Specifies whether to register the read or write input and output ports.
Use clock enable for input and output registers.	On/Off	Specifies whether to turn on the option to create one clock enable signal for the input and output registers.
Create an 'aclr' asynchronous clear for the output ports. • 'q_a' port • 'q_b' port	On/Off	Specifies whether to create an asynchronous clear port for the output ports.
Create an 'sclr' synchronous clear for the output ports. • 'q_a' port • 'q_b' port	On/Off	Specifies whether to create a synchronous clear port for the output ports.
Parameter Settings: Output 1		
How should the 'q_a' and 'q_b' outputs behave when reading a memory location that is being written from the other port? The output of port A will be 'NEW' while the output of port B will be 'OLD'	On/Off	Specifies the output behavior when read-during-write occurs.
Parameter Settings: Output 2		
What should the 'q_a' output be when reading from a memory location being written to?	Don't Care	Specifies the output behavior when read-during-write occurs.
What should the 'q_b' output be when reading from a memory location being written to?		
Parameter Settings: Mem Init		
Do you want to specify the initial content of the memory?	• No, leave it blank • Yes, use this file for the memory content data	Specifies the initial content of the memory. To initialize the memory to zero, select **No, leave it blank.** To use a memory initialization file (**.mif**) or a hexadecimal (Intel-format) file (**.hex**), select **Yes, use this file for the memory content data**.
Initialize memory content data to XX..X on power-up simulation	On/Off	—
The initial content file should conform to which port's dimensions?	PORT_A, PORT_B	If you select to use the initial content file for memory content data, select the port the file should conform to.

continued...

Parameter	Legal Values	Description
Implement clock-enable circuitry for use in a partial reconfiguration region	On/Off	Specifies whether to implement clock-enable circuitry for use in a partial reconfiguration region.
Parameter Settings: Performance Optimization		
Enable Force-to-Zero	On/Off	Specifies whether to set the output to zero when you deassert the read enable signal. Enabling this feature helps improve the glue logic performance when the selected memory depth is larger than a single memory block.

4.1.6. ROM: 1-PORT Intel FPGA IP Parameters

This table lists the parameters for the ROM: 1-PORT Intel FPGA IP core.

Table 24. ROM: 1-PORT Intel FPGA IP Parameter Settings

Parameter	Legal Values	Description
Parameter Settings: General Page		
How wide should the 'q' output bus be?	—	Specifies the width of the 'q' output bus.
How many words of memory?	—	Specifies the number of words.
What should the memory block type be?	Auto, MLAB, M20K	Specifies the memory block type. The types of memory block that are available for selection depends on your target device.
Set the maximum block depth to	• MLAB: Auto, 32 • M20K: Auto, 512, 1024, 2048	Specifies the maximum block depth in words.
What clocking method would you like to use?	• Single clock • Dual clock: use separate 'input' and 'output' clocks	Specifies the clocking method to use. • **Single clock**—A single clock and a clock enable controls all registers of the memory block • **Dual clock: use separate 'input' and 'output' clocks**—The input clock controls the address registers and the output clock controls the data-out registers. There are no write-enable, byte-enable, or data-in registers in ROM mode.
Parameter Settings: Regs/Clken/Aclrs		
Which ports should be registered?	On/Off	Specifies whether to register the input and output ports.

continued...

Parameter	Legal Values	Description
The following options are available: • 'address' input port • 'q' output port		
Use clock enable for port A input registers	On/Off	Specifies whether to use clock enable for port A input registers.
Use clock enable for port A output registers	On/Off	Specifies whether to use clock enable for port A output registers.
Create an 'addressstall_a' input port.	On/Off	Specifies whether to create an addressstall_a input port. You can create this port to act as an extra active low clock enable input for the address registers.
Create an 'aclr' asynchronous clear for the registered ports. The following options are available: • 'address' port • 'q' port	On/Off	Specifies whether the registered ports be affected by an asynchronous clear port.
Create a 'sclr' asynchronous clear for the registered ports. 'q' port	On/Off	Specifies whether the q port be affected by a synchronous clear port.
Create an 'rden' read enable signal	On/Off	Specifies whether to create a read enable signal.
Parameter Settings: Mem Init		
Do you want to specify the initial content of the memory?	• No, leave it blank • Yes, use this file for the memory content data	Specifies the initial content of the memory. In ROM mode, you must specify a memory initialization file (**.mif**) or a hexadecimal (Intel-format) file (**.hex**). The **Yes, use this file for the memory content data** option is turned on by default.
The initial content file should conform to which port's dimensions?	PORT_A	The initial content file for memory content data only conforms to port A.
Allow In-System Memory Content Editor to capture and update content independently of the system clock	On/Off	Specifies whether to allow In-System Memory Content Editor to capture and update content independently of the system clock
The 'Instance ID' of this ROM is	NONE	Specifies the ROM ID.
Parameter Settings: Performance Optimization		
Enable Force-to-Zero	On/Off	Specifies whether to set the output to zero when you deassert the read enable signal. Enabling this feature helps improve the glue logic performance when the selected memory depth is larger than a single memory block.

4.1.7. ROM: 2-PORT Intel FPGA IP Parameters

This table lists the parameters for the ROM: 2-PORT Intel FPGA IP core.

Table 25. ROM: 2-PORT Intel FPGA IP Parameter Settings

Parameter	Legal Values	Description
Parameter Settings: Widths/Blk Type		
How do you want to specify the memory size?	• As a number of words • As a number of bits	Determines whether to specify the memory size in words or bits.
How many words of memory?	32, 64, 128, 256, 512, 1024, 2048, 4096, 8192, 16384, 32768, 65536	Specifies the number of words.
Use different data widths on different ports	On/Off	Specifies whether to use different data widths on different ports.
How wide should the 'q_a' output bus be?	—	Specifies the width of the 'q_a' and 'q_b' output ports.
How wide should the 'q_b' output bus be?		
RAM block type	Auto, M20K	Specifies the memory block type. The types of memory block that are available for selection depends on your target device
Set the maximum block depth to	M20K: Auto, 512, 1024, 2048	Specifies the maximum block depth in words. This option is enabled only when you choose **Auto** as the memory block type.
Parameter Settings: Clks/Rd, Byte En		
What clocking method would you like to use?	• Single clock • Dual clock: use separate 'input' and 'output' clocks • Customize clocks for A and B ports	Specifies the clocking method to use. • **Single**—A single clock and a clock enable controls all registers of the memory block • **Dual clock: use separate 'input' and 'output' clocks**—The input clock controls the address registers and the output clock controls the data-out registers. There are no write-enable, byte-enable, or data-in registers in ROM mode. • **Customize clocks for A and B ports**—Clock A controls all registers on the port A side; clock B controls all registers on the port B side. Each port also supports independent clock enables for both port A and port B registers, respectively.

continued...

Parameter	Legal Values	Description
Create a 'rden_a' and 'rden_b' read enable signals	On/Off	Specifies whether to create read enable signals.
Parameter Settings: Regs/Clkens/Aclrs		
Which ports should be registered? Read output ports	On/Off	Specifies whether to register the read output ports.
'q_a' port	On/Off	Specifies whether to register the 'q_a' output port.
'q_b' port	On/Off	Specifies whether to register the 'q_b' output port.
Use clock enable for port A input registers	On/Off	Specifies whether to use clock enable for port A input registers.
Use clock enable for port A output registers	On/Off	Specifies whether to use clock enable for port A output registers.
Use clock enable for port B input registers	On/Off	Specifies whether to use clock enable for port B input registers.
Use clock enable for port B output registers	On/Off	Specifies whether to use clock enable for port B output registers.
Create an 'addressstall_a' input port.	On/Off	Specifies whether to create addressstall_a and addressstall_b input ports. You can create these ports to act as an extra active low clock enable input for the address registers.
Create an 'addressstall_b' input port.	On/Off	Specifies whether to create an asynchronous clear port for the registered ports.
Aclr Options • 'q_a' port • 'q_b' port	On/Off	Specifies whether the registered ports should be cleared by the asynchronous clear port.
Sclr Options • 'q_a' port • 'q_b' port	On/Off	Specifies whether the registered ports should be cleared by the synchronous clear port.
Parameter Settings: Mem Init		
Do you want to specify the initial content of the memory?	• No, leave it blank • Yes, use this file for the memory content data	Specifies the initial content of the memory. In ROM mode, you must specify a memory initialization file (**.mif**) or a hexadecimal (Intel-format) file (**.hex**). The **Yes, use this file for the memory content data** option is turned on by default.

continued...

Parameter	Legal Values	Description
The initial content file should conform to which port's dimensions?	• PORT_A • PORT_B	Specifies whether the initial content file conforms to port A or port B.
Parameter Settings: Performance Optimization		
Enable Force-to-Zero	On/Off	Specifies whether to set the output to zero when you deassert the read enable signal. Enabling this feature helps improve the glue logic performance when the selected memory depth is larger than a single memory block.

4.1.8. RAM and ROM Interface Signals

Table 26. Interface Signals of the Intel Stratix 10 RAM and ROM Intel FPGA IP Cores

Signal	Direction	Required	Description
data_a	Input	Optional	Data input to port A of the memory. The data_a port is required for all RAM operation modes: • SINGLE_PORT • DUAL_PORT • BIDIR_DUAL_PORT • QUAD_PORT
address_a	Input	Yes	Address input to port A of the memory. The address_a signal is required for all operation modes.
address2_a	Input	Yes (for simple quad-port)	Read address input to port A of the memory. The address2_a signal is required if the operation_mode parameter is set to QUAD_PORT.
wren_a	Input	Optional	Write enable input for address_a port. The wren_a signal is required all RAM operation modes: • SINGLE_PORT • DUAL_PORT • BIDIR_DUAL_PORT • QUAD_PORT
rden_a	Input	Optional	Read enable input for address_a port. The rden_a signal is supported depending on your selected memory mode and memory block.
byteena_a	Input	Optional	Byte enable input to mask the data_a port so that only specific bytes, nibbles, or bits of the data are written. The byteena_a port is not supported in the following conditions: • If implement_in_les parameter is set to ON • If operation_mode parameter is set to ROM
addressstall_a	Input	Optional	Address clock enable input to hold the previous address of address_a port for provided that the addressstall_a port is high.
q_a	Output	Yes	Data output from port A of the memory.

continued...

Signal	Direction	Required	Description
			The q_a port is required if the operation_mode parameter is set to any of the following values: • SINGLE_PORT • BIDIR_DUAL_PORT • QUAD_PORT • ROM The width of q_a port must be equal to the width of data_a port.
data_b	Input	Optional	Data input to port B of the memory. The data_b port is required if the operation_mode parameter is set to BIDIR_DUAL_PORT.
address_b	Input	Optional	Address input to port B of the memory. The address_b port is required if the operation_mode parameter is set to the following values: • DUAL_PORT • BIDIR_DUAL_PORT • QUAD_PORT
address2_b	Input	Yes (for simple quad-port)	Read address input to port B of the memory. The address2_b is required if the operation_mode parameter is set to QUAD_PORT.
wren_b	Input	Yes	Write enable input for address_b port. The wren_b port is required if operation_mode is set to BIDIR_DUAL_PORT.
rden_b	Input	Optional	Read enable input for address_b port. The rden_b port is supported depending on your selected memory mode and memory block
byteena_b	Input	Optional	Byte enable input to mask the data_b port so that only specific bytes, nibbles, or bits of the data are written. The byteena_b port is not supported in the following conditions: • If implement_in_les parameter is set to ON • If operation_mode parameter is set to SINGLE_PORT, DUAL_PORT, or ROM
q_b	Output	Yes	Data output from port B of the memory. The q_b port is required if the operation_mode is set to the following values: • DUAL_PORT • BIDIR_DUAL_PORT • QUAD_PORT The width of q_b port must be equal to the width of data_b port.
clock0	Input	Yes	The following describes which of your memory clock must be connected to the clock0 port, and port synchronization in different clocking modes:

continued...

Signal	Direction	Required	Description
			• Single clock: Connect your single source clock to `clock0` port. All registered ports are synchronized by the same source clock. • Read/Write: Connect your write clock to `clock0` port. All registered ports related to write operation, such as `data_a` port, `address_a` port, `wren_a` port, and `byteena_a` port are synchronized by the write clock. • Input Output: Connect your input clock to `clock0` port. All registered input ports are synchronized by the input clock. • Independent clock: Connect your port A clock to `clock0` port. All registered input and output ports of port A are synchronized by the port A clock.
`clock1`	Input	Optional	The following describes which of your memory clock must be connected to the `clock1` port, and port synchronization in different clocking modes: • Single clock: Not applicable. All registered ports are synchronized by `clock0` port. • Read/Write: Connect your read clock to `clock1` port. All registered ports related to read operation, such as `address_b` port, `rden_b` port, and `q_b` port are synchronized by the read clock. • Input Output: Connect your output clock to `clock1` port. All the registered output ports are synchronized by the output clock. • Independent clock: Connect your port B clock to `clock1` port. All registered input and output ports of port B are synchronized by the port B clock.
`clocken0`	Input	Optional	Clock enable input for `clock0` port.
`clocken1`	Input	Optional	Clock enable input for `clock1` port.
`eccstatus`	Output	Optional	A 3-bit wide error correction status port. Indicate whether the data that is read from the memory has an error in single-bit with correction, fatal error with no correction, or no error bit occurs. In Stratix V devices, the M20K ECC status is communicated with two-bit wide error correction status port. The M20K ECC detects and fixes a single bit error event or a double adjacent error event, or detects three adjacent errors without fixing the errors. The `eccstatus` port is supported if all the following conditions are met: • `operation_mode` parameter is set to `DUAL_PORT` • `ram_block_type` parameter is set to `M20K` • `width_a` and `width_b` parameter have the same value • Byte enable is not used
`eccencbypass`	Input	Optional	When active, this port allow user to inject parity bits through `eccencparity` ports. When inactive, parity bits will be generated using internal ecc encoder. This port can only be used when `enable_ecc_encoder_bypass` is set to "TRUE".
`eccencparity`	Input	Optional	When `eccencbypass` is active, user can inject 8-bits parity through `eccencparity` port. This port can be used only when `enable_ecc_encoder_bypass` is set to "TRUE".
`data`	Input	Yes	Data input to the memory. The data port is required and the width must be equal to the width of the `q` port.

continued...

Signal	Direction	Required	Description
wraddress	Input	Yes	Write address input to the memory. The wraddress port is required and must be equal to the width of the raddress port.
wren	Input	Yes	Write enable input for wraddress port. The wren port is required.
rdaddress	Input	Yes	Read address input to the memory. The rdaddress port is required and must be equal to the width of wraddress port.
rden	Input	Optional	Read enable input for rdaddress port. The rden port is supported when the use_eab parameter is set to OFF. The rden port is not supported when the ram_block_type parameter is set to MLAB. Create an instance of the ALTSYNCRAM IP core if you want to use read enable feature with other memory blocks.
byteena	Input	Optional	Byte enable input to mask the data port so that only specific bytes, nibbles, or bits of data are written. It is supported in Intel Stratix 10 devices when you set the ram_block_type parameter to MLAB.
wraddressstall	Input	Optional	Write address clock enable input to hold the previous write address of wraddress port for as long as the wraddressstall port is high.
rdaddressstall	Input	Optional	Read address clock enable input to hold the previous read address of rdaddress port for as long as the wraddressstall port is high.
q	Output	Yes	Data output from the memory. The q port is required, and must be equal to the width data port.
inclock	Input	Yes	The following describes which of your memory clock must be connected to the inclock port, and port synchronization in different clocking modes: • Single clock: Connect your single source clock to inclock port and outclock port. All registered ports are synchronized by the same source clock. • Read/Write: Connect your write clock to inclock port. All registered ports related to write operation, such as data port, wraddress port, wren port, and byteena port are synchronized by the write clock. • Input/Output: Connect your input clock to inclock port. All registered input ports are synchronized by the input clock.
outclock	Input	Yes	The following describes which of your memory clock must be connected to the outclock port, and port synchronization in different clocking modes: • Single clock: Connect your single source clock to inclock port and outclock port. All registered ports are synchronized by the same source clock. • Read/Write: Connect your read clock to outclock port. All registered ports related to read operation, such as rdaddress port, rdren port, and q port are synchronized by the read clock. • Input/Output: Connect your output clock to outclock port. The registered q port is synchronized by the output clock.
inclocken	Input	Optional	Clock enable input for inclock port.

continued...

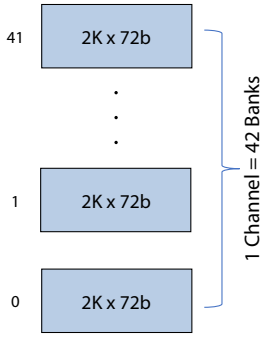
Signal	Direction	Required	Description
`outclocken`	Input	Optional	Clock enable input for `outclock` port.
`aclr`	Input	Optional	Asynchronously clear the output ports. The asynchronous clear effect on the registered ports can be controlled through their corresponding clear parameter, such as `outdata_aclr_a` and `outdata_aclr_b`.
`sclr`	Input	Optional	Synchronously clear the output ports. The synchronous clear effect on the registered ports can be controlled through their corresponding parameter, such as `outdata_sclr_a` and `outdata_sclr_b`.

4.2. eSRAM Intel FPGA IP

The basic building block of the native eSRAM Intel FPGA IP core is a bank, which consists of an array of 2K x 72-bit SRAM blocks.

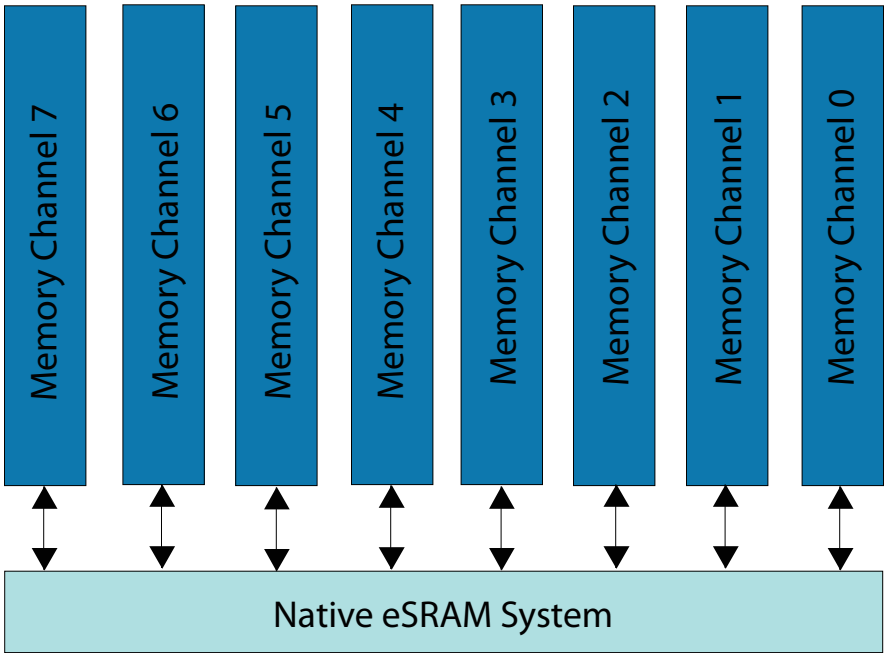
Forty two eSRAM banks combine to form a channel.

Figure 25. eSRAM Channel



Eight memory channels combine to form an eSRAM system.

Figure 26. eSRAM System



Related Information

Intel Stratix 10 Embedded Memory Configurations on page 22

4.2.1. eSRAM System Features

An eSRAM system provides features for handling simultaneous read and write requests, ensuring data integrity and coherency, and maximizing power efficiency.

A given eSRAM system can achieve a maximum frequency of 750 MHz. The number of available eSRAM systems depends on the Intel Stratix 10 device in use.

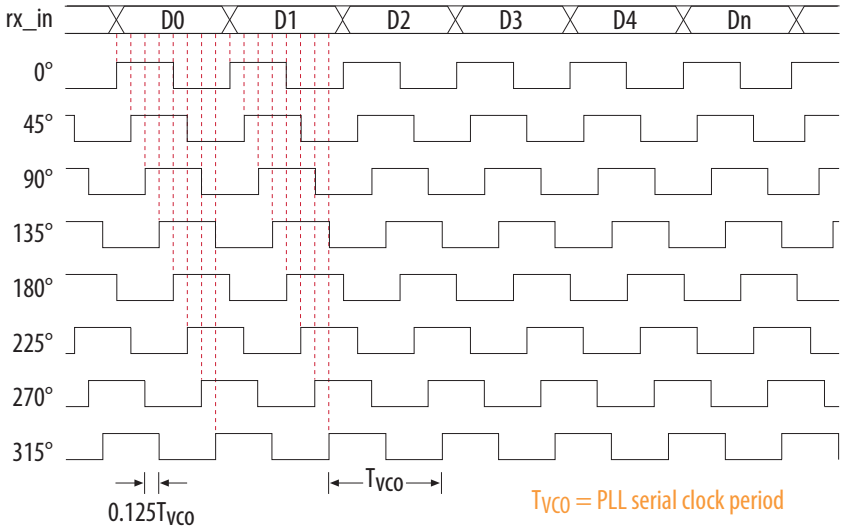
Every memory channel within an eSRAM system has one write port and one read port, which can handle simultaneous read and write requests. Each channel has access to only its own banks, thus ensuring that each channel is independent from its neighbors.

The eSRAM system has an error correction code (ECC) which you can enable at the cost of some user-accessible data capacity. The ECC can improve data integrity by encoding write data with extended Hamming code and decoding read data for Single-bit Error Correction, Double-bit Error Detection (SECDED). Write latency and read latency are the same whether ECC is enabled or not.

There is a data coherency feature called Write Forwarding which you can enable to handle simultaneous write and read access to the same eSRAM memory location. The write data on the write port is forwarded to the read port and not read from the targeted SRAM bank. The write data is still written into the targeted eSRAM bank.

A low power mode can conserve static power at the cost of 1 clock cycle. In addition, each channel can power down unused banks, for additional power savings.

The eSRAM system includes a PLL which natively drives the clock domains necessary for eSRAM operation.



4.2.1.1. eSRAM Specifications

The following table summarizes the specifications of the eSRAM Intel FPGA IP core.

Table 27. eSRAM Specifications

Feature	Detail	Value	Description
Clock Frequency (5)	-1 -2 -3	200 MHz - 750 MHz 200 MHz - 640 MHz 200 MHz - 500 MHz (6)	—
Bank Capacity	without ECC with ECC	144 Kb 128 Kb	Each bank is (2048) 2K x 72 bits
Banks per Channel	—	42	—
Channel Capacity	without ECC with ECC	5.90625 Mb 5.25 Mb	—
Channels per eSRAM	—	8	—
eSRAM Capacity	without ECC with ECC	47.25 Mb 42 Mb	—
Interface Data Width	without ECC with ECC	x72 x64	Maximum width

continued...

(5) The input clock source for eSRAM must not exceed 20 ps peak-to-peak, or 1.42 ps RMS at 1e-12 BER, 1.22 ps at 1e-16 BER.

(6) In Speed Grade 3 devices, the following clock frequency range is not supported:
- 466.51 MHz - 499.99 MHz
- 233.26 MHz - 249.99 MHz

Feature	Detail	Value	Description
Read Latency [7]	Normal Low Power	10 +2 [8] 11 + 2 [8]	These latencies are fixed, whether ECC is enabled or not.
Write Latency	—	0 +1 [9]	There is a zero cycle latency for write commands issued to the eSRAM.
Power (per eSRAM system)	Industrial Extended	1.15 W - 1.5 W 2.28 W - 3.31 W	Low Power mode to Normal mode.

4.2.1.2. eSRAM Usage Model

The eSRAM configuration is deemed static after FPGA configuration. You cannot reconfigure the eSRAM after it enters user mode.

All 8 memory channels have an interface to a shared set of 3 fabric sectors. The fitter chooses which sector interfaces with core logic because not all the sectors are available for each eSRAM.

The reference clock (`refclk`) is only support LVDS standard. When setting an instance assigment, use the correct standard for `refclk`. An instance assignment must be set to use the correct standard for `refclk`:

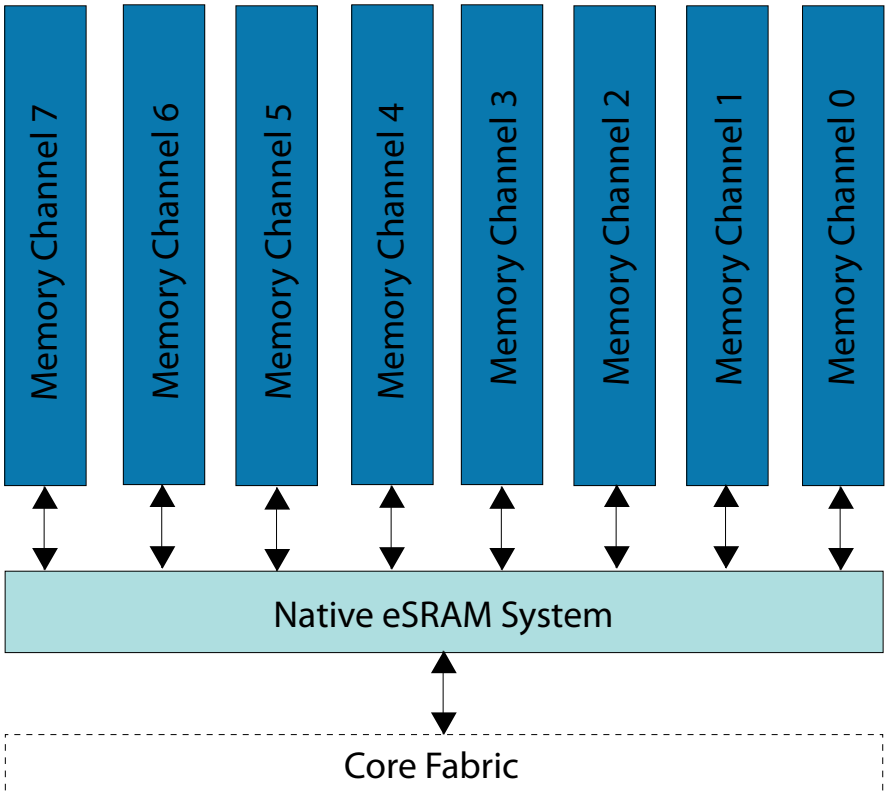
```
set_instance_assignment -name IO_STANDARD LVDS -to refclk
```

(7) Read latency is measured from a read command being presented to the interface to valid read data being returned.

(8) +2 on read latency is added due to registers interfacing with eSRAM required to meet routing and timing requirement.

(9) +1 on read latency is added due to registers interfacing with eSRAM required to meet routing and timing requirement.

Figure 27. eSRAM Interface With Core Logic



There is a maximum of 17 address bits available. Address bits [10:0] are the 11 bits used to target the 2K entries in a bank. Address bits [16:11] are the 6 bits used to target a certain bank in a channel. Because there are only 42 Banks in a channel, the threshold address you can target is [16:11] = 6'b101001 (41st bank relative to the 0th Bank).

Note: eSRAM bits cannot be reset while in user mode and hence do not have a reset requirement.

Each of the 8 memory channels that make up an eSRAM can power down unused banks. You are responsible for selecting the desired capacity in the eSRAM Intel FPGA IP core as the unused banks are powered down by default.

4.2.2. eSRAM Intel FPGA IP Parameters

The parameters allow you to select the channels that you want to implement.

Table 28. eSRAM Intel FPGA IP Parameter Editor: General Tab

Parameter	Legal Values	Description
Interface		
Interface	On/Off	Specifies the channel to be enabled for eSRAM. There are 8 channels per eSRAM.

continued...

Parameter	Legal Values	Description
• Enable Channel 0 • Enable Channel 1 • Enable Channel 2 • Enable Channel 3 • Enable Channel 4 • Enable Channel 5 • Enable Channel 6 • Enable Channel 7		• **Enable Channel 0**—This option enables Channel 0 for eSRAM. • **Enable Channel 1**—This option enables Channel 1 for eSRAM. • **Enable Channel 2**—This option enables Channel 2 for eSRAM. • **Enable Channel 3**—This option enables Channel 3 for eSRAM. • **Enable Channel 4**—This option enables Channel 4 for eSRAM. • **Enable Channel 5**—This option enables Channel 5 for eSRAM. • **Enable Channel 6**—This option enables Channel 6 for eSRAM. • **Enable Channel 7**—This option enables Channel 7 for eSRAM.
PLL		
PLL Reference Clock Frequency	—	Specifies the PLL reference clock frequency to the eSRAM PLL. The valid ranges is 10 - 325 MHz for any device's speed grade.
PLL Desired Clock Frequency	—	Specifies the PLL desired output clock frequency which is the frequency to the eSRAM. The valid ranges is 200 - 750 MHz depending on the speed grade of your device.

Table 29. eSRAM Intel FPGA IP Core Parameter Editor: Channel Tab

Parameter	Legal Values	Description
Channel Width and Depth		
How wide should the data bus be?	—	Specifies the width of the data bus. • Normal mode: 1 to 72 bits • ECC enable only: 1 to 64 bits • Both ECC and ECC Encoder and Decoder Bypass enabled: 72 bits only
How many words of memory?	—	Specifies how many memory banks to use out of the possible 42 banks available per eSRAM channel. Banks are specified in increments of 2048 words, where each 2048 words equals one bank. The number of banks specified determines the address width available to the user. Banks that are not used are powered off and cannot be activated after parameterization. *Note:* If you attempt to address a bank that has not been enabled, any resulting data will be random and without value.
Channel Features		
Enable ECC Encoder and Decoder	On/Off	Enables the ECC encoder and decoder, which assists in maintaining the integrity of data written to and read from the eSRAM.

continued...

Parameter	Legal Values	Description
		Note: When you enable the ECC encoder and decoder, the maximum data bus width decreases from 72 bits to 64 bits. The 8 bit difference is used in the parity calculations required by the ECC encoder and decoder.
Enable Dynamic ECC Encoder and Decoder Bypass	On/Off	Enables users to dynamically bypass the ECC encoder and/or decoder, by asserting `eccencbypass` or `eccdecbypass`. This feature is useful for debugging purposes.
Enable Write Forwarding	On/Off	Enables write forwarding, which ensures data coherency when writing to and reading from the same address in the eSRAM. Write forwarding takes the data present on the write port and forwards it to the read port as read data. Write-forwarded read data requires the same duration of time as a regular read. Read logic does not use data stored in the targeted address, but the data is still written to the address.
Enable Low Power Mode	On/Off	Enables Low Power mode, which reduces power consumption by placing all eSRAM memory banks into a state of light sleep. When a bank is targeted for access, it is awakened one cycle prior to the access. The bank returns to a state of light sleep after the access is completed. Low Power mode does not alter the content of a memory bank. One drawback of Low Power mode is that it increases read latency from 10+2 to 11+2.

4.2.3. eSRAM Intel FPGA IP Interface Signals

The following table lists the input and output signals of the eSRAM Intel FPGA IP interface.

Table 30. eSRAM Intel FPGA IP Input and Output Signals

Signal	Direction	Width	Description
`refclk`	Input	1	Provide a PLL reference clock.
`esram2f_clk`	Output	1	Core clock provided by the eSRAM to the fabric. Use this clock to drive core logics that are interfacing with the eSRAM. Otherwise, proper cross-clock domain circuitry is expected.

continued...

Signal	Direction	Width	Description
c<*channel_number*>_data_0	Input	1-72	• 72 for clear channel data, or • 64 when ECC is enabled, or • 72 when ECC Bypass is enabled, the MSB (most significant bit) of data (data[71:64]) represents the parity bits.
c<*channel_number*>_wraddress_0	Input	Range from 17–11	Write address of the memory. Dependent on how many banks are enabled in the channel. *Note:* Writing to an invalid address does nothing, because the targeted bank is not powered.
c<*channel_number*>_wren_n_0	Input	1	Active low write enable input for the wraddress port.
c<*channel_number*>_rdaddress_0	Input	Range from 17–11	Read address of the memory. Dependent on how many banks are enabled in the channel. *Note:* If you attempt to read from an invalid address, the data returned is random and of no value.
c<*channel_number*>_rden_n_0	Input	1	Active low read enable input for the rdaddress port.
c<*channel_number*>_q_0	Output	72 or 64	• 72 for clear channel data, or • 64 when ECC is enabled, or • 72 when ECC Bypass is enabled, the MSB of output (q[71:64]) represents the parity bits.
ECC Enabled			
c<*channel_number*>_error_detect_0	Output	1	Asserts when an ECC error occurred on the read data retrieved from the eSRAM.
c<*channel_number*>_error_correct_0	Output	1	Asserts when an ECC error is successfully corrected. The memory content is not updated with the corrected data.
Dynamic ECC Bypass Enabled			
c<*channel_number*>_eccencbypass_0	Input	1	Dynamically bypass the ECC Encoder. When active, this port allows user to inject parity bits through 8-bits MSB from data port (c<channel_number>_data_0[71:64]). When inactive, parity bits will be generated using internal ECC Encoder. This port can only be used when c<channel_number>_ecc_byp_enable parameter is set to "TRUE".
c<*channel_number*>_eccdecbypass_0	Input	1	Dynamically bypass the ECC Decoder. 8-bits MSB from output port (c<channel_number>_q_0[73:64]) represents the parity bits. Parity bits are not checked and the c<*channel_number*>_error_detect_0 and c<*channel_number*>_error_correct_0 signals should not assert. This port

continued...

Signal	Direction	Width	Description
			can only be used when c<*channel_number*>_ecc_byp_enable parameter is set to "TRUE".
Additional Options			
c<*channel_number*>_sd_n_0	Input	1	Active low signal that dynamically shuts down channels. This signal shuts down power to periphery (active low) and memory core of the banks within the channel, with no memory data retention. In addition to the channels that are statically shut down when choosing the number of channels to use in an eSRAM system, you can also dynamically shut down channels at run time. *Note:* Memory contents are not retained when a channel is shut down.
iopll_lock2core	Output	1	eSRAM IOPLL lock status. • High—Locked • Low—Unlocked or lock loss.

4.2.4. eSRAM Intel FPGA IP Simulation Walk Through

The IOPLL is included in the eSRAM Intel FPGA IP core to drive its clock domains for operation. The testbench should wait for the IOPLL to be locked before starting any simulation to ensure the clock entering the eSRAM is always stable. During the waiting period for the IOPLL to lock, the eSRAM will not function properly due to unstable clock frequency. In hardware, the testbench does not need to check the IOPLL lock signal because the IOPLL lock signal is asserted at the configuration stage, which is handled by firmware. The wait for the IOPLL lock is only needed to perform in software simulation.

You can check the LOCK signal from the output port `iopll_lock2core` in the eSRAM IP design. Simulation can only start after the `iopll_lock2core` signal goes from LOW to HIGH.

Note: Before starting the simulation, you must provide sufficient delay (for example, 10 us) for the clock to be stable enough after the eSRAM's IOPLL is locked (`iopll_lock2core` signal goes from LOW to HIGH).

4.2.5. eSRAM Timing Diagrams

The timing diagrams show the signal behavior of the eSRAM in normal and low power modes.

Figure 28. eSRAM in Normal Mode

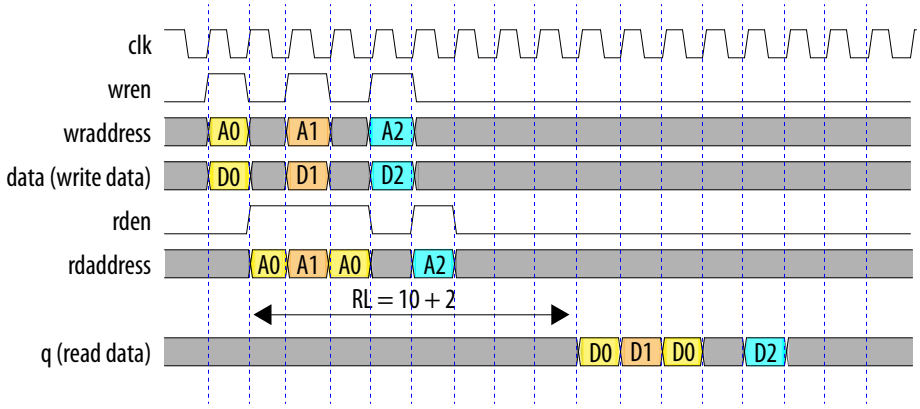
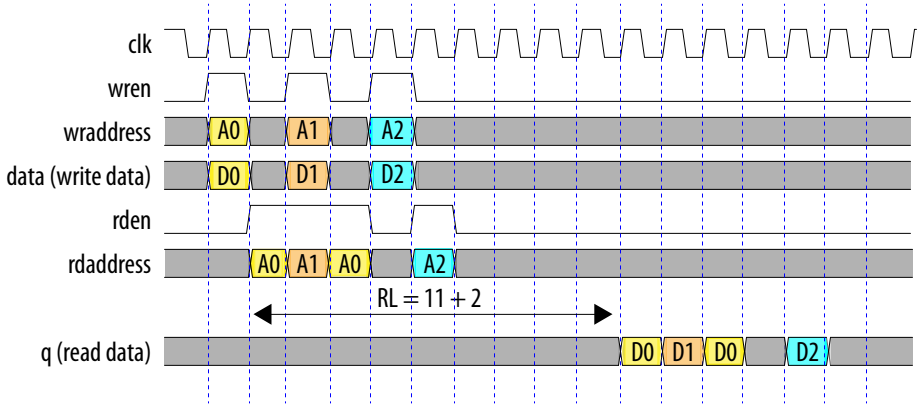


Figure 29. eSRAM in Low-Power Mode



4.3. FIFO Intel FPGA IP

Intel provides FIFO Intel FPGA IP core through the parameterizable single-clock FIFO (SCFIFO) and dual-clock FIFO (DCFIFO) functions.

The FIFO functions are mostly applied in data buffering applications that comply with the first-in-first-out data flow in synchronous or asynchronous clock domains.

The specific names of the FIFO functions are as follows:

- SCFIFO: single-clock FIFO
- DCFIFO: dual-clock FIFO (supports same port widths for input and output data)
- DCFIFO_MIXED_WIDTHS: dual-clock FIFO (supports different port widths for input and output data)

Note: The term "DCFIFO" refers to both the DCFIFO and DCFIFO_MIXED_WIDTHS IP cores, unless specified.

Related Information

FIFO Intel FPGA IP Core User Guide

4.3.1. FIFO Intel FPGA IP Parameters

Table 31. FIFO Intel FPGA IP Parameters Description

This table lists the parameters for the FIFO Intel FPGA IP core.

Parameter	Legal Values	Description
Parameter Settings: Width, Clk, Synchronization		
How wide should the FIFO be?	—	Specifies the width of the data and q ports.
How deep should the FIFO be? Note: You could enter arbritary values for width	4, 8, 16, 32, 64, 128, 256, 512, 1024, 2048, 4096, 8192, 16384, 32768, 65536, 131072	Specifies the depth of the FIFO, which is always a power of 2.
Do you want a common clock for reading and writing the FIFO?	• Yes, synchronize both reading and writing to 'clock'. Create one set of full/empty control signals. • No, syncronize reading and writing to 'rdclk' and 'wrclk', respectively. Create a set of full/empty control signals for for each clock.	—
Parameter Settings: SCFIFO Options		
Would you like to disable any circuitry protection? • full • empty • usedw[] (number of words in FIFO). Note: You can use the MSB to generate a half full flag. • almost full becomes true when usedw[] is greater than or equal to • almost empty becomes true when usedw[] is less than • Asyncronous clear • Syncronous clear (flush the FIFO)	On/Off	—
Parameter Settings: DCFIFO 1		
When you select **No, syncronize reading and writing to 'rdclk' and 'wrclk', respectively. Create a set of full/empty control signals for for each clock.**, the following options are available: Total latency, clock synchronization, metastability protection, area, and fmax options must be set as a group. Total latency is the sum of two write clock rising edges and the number of read clocks selected below. Which option(s) is most important to the DCFIFO? (Read clk sync stages, metastability protection, area, fmax)	On/Off	Specify total latency, clock synchronization, metastability protection, area, and fmax.

continued...

Parameter		Legal Values	Description
Which type of optimization do you want? • Lowest latency but requires synchronized clocks. 1 sync stage, no metastability protection, smallest size, good fmax. • Minimal setting for unsyncronized clocks. 2 sync stages, good metastability, medium size, good fmax. • Best metastability protection, best fmax, unsynchronized clocks. 3 or more sync stages, best metastability protection, largest size, best fmax.			• **Lowest latency but requires synchronized clocks**—This option uses one synchronization stage with no metastability protection. It uses the smallest size and provides good f_{MAX}. Select this option if the read and write clocks are related clocks. • **Minimal setting for unsyncronized clocks**—This option uses two synchronization stages with good metastability protection. It uses the medium size and provides good f_{MAX}. • **Best metastability protection, best fmax, unsynchronized clocks**—This option uses three or more synchronization stages with the best metastability protection. It uses the largest size but gives the best f_{MAX}.
More options	When you select **Best metastability protection, best fmax, unsynchronized clock**, the following option is available: • How many sync stages?	3, 4, 5, 6, 7, 8, 9	Specifies the number syncronization stages.
Timing Constraint • Generate SDC file and disable embedded timing constraint		On/Off	Generate a SDC file with correct timing constraints. Embedded `set_false_path` assignment is disabled. The new timing constraints consist of `set_net_delay`, `set_max_skew`, `set_min_delay` and `set_max_delay`. For more infomation on the timing constraint usage, refer to user guide.
Parameter Settings: DCFIFO 2			
When you select **No, syncronize reading and writing to 'rdclk' and 'wrclk', respectively. Create a set of full/empty control signals for for each clock.**, the following options are available: Which optional output control signals do you want? usedw[] is the number of words in the FIFO.		On/Off	
Read-side • full • empty • usedw[] Note: These signals are syncronous to 'rdclk'.			
Write-side • full • empty • usedw[] Note: These signals are syncronous to 'wrclk'.			

continued...

Parameter		Legal Values	Description
More options	• Add an extra MSB to usedw port(s). Note: You can use the MSB to generate a half-full flag. • Asynchronous clear • Add circuit to synchronize 'aclr' input with 'wrclk' • Add circuit to synchronize 'aclr' input with 'rdclk'	On/Off	
Parameter Settings: Rdreq Option, Blk Type			
Which kind of read access do you want with the 'rdreq' signal?		• Normal synchronous FIFO mode. • Show-ahead synchronous FIFO mode.	Specifies whether the FIFO is in Legacy mode or in Show-ahead mode. • **Normal synchronous FIFO mode**—The data becomes available after 'rdreq is asserted. 'rdreq' acts as a read request. • **Show-ahead synchronous FIFO mode**—The data becomes available before 'rdreq' is asserted. 'rdreq' acts as a read acknowledge. Note: This mode suffers a performance penalty.
What should the memory block type be?		• Auto • MLAB • M20K • M144K	Specifies the memory block type. The types of memory block that are available for selection depends on your target device.
Set the maximum block depth to:		Auto, 32, 64, 128, 256, 512, 1024, 2048, 4096, 8192, 16384, 32768, 65536, 131072	Specifies the maximum block depth in words.
Reduce RAM usage (decreases speed and increases number of Les). Available if data width is divisible by 9.		On/Off	
Parameter Settings: Optimization, Circuitry Protection			
Would you like to register the output to maximize performance but use more area?		• Yes (best speed) • No (smallest area)	Specifies whether to register the RAM output.
Implement FIFO storage with logic cells only, even if the device contains memory blocks.		On/Off	Specifies whether to implement FIFO storage with logic cells only.
Would you like to disable any circuitry protection (overflow checking and underflow checking)? If not required, overflow and underflow checking can be disabled to improve performance. • Disable overflow checking. Writing to a full FIFO will corrupt contents. • Disable underflow checking. Reading from an empty FIFO will corrupt contents		On/Off	Specifies whether to disable any circuitry protection for overflow
Would you like to enable ECC? • Enable error checking and correcting (ECC)		On/Off	Specifies whether to enable error checking and correcting feature.

4.3.2. Reset Scheme

During power up, the registers in Intel Stratix 10 devices are in undefined power and reset states. To guarantee correct functionality, reset the FIFO Intel FPGA IP core upon completion of configuration by asserting either the `sclr` or `aclr` signal. Reset is not required if `sclr` or `aclr` signal is not used in the FIFO Intel FPGA IP core.

4.4. FIFO2 Intel FPGA IP

Intel provides FIFO2 Intel FPGA IP core as an alternative solution for the FIFO Intel FPGA IP core for applications running at wide data width and very high operating frequencies (Fmax) to achieve high data bandwidth.

The FIFO functions in the FIFO2 Intel FPGA IP core are mostly applied in data buffering applications that comply with the first-in-first-out data flow in synchronous or asynchronous clock domains.

Note: The FIFO2 Intel FPGA IP core has no backward compatibility to the FIFO Intel FPGA IP core.

Table 32. Differences between FIFO and FIFO2 Intel FPGA IP Cores

Feature	Intel FPGA IP Cores	
	FIFO	FIFO2
Read latency	0 - 1 clock cycle after the `rdreq` signal is asserted.	3 - 4 clock cycle after the `rdreq` is asserted.
Read valid when	`r_empty` signal is low	`r_valid` signal is high
Show-ahead mode	Supported	Not supported
Depth (D) and width (W) configuration	Per user requirement	Multiple of hard memory block only (32W x 512D for M20K, 20W x 32D for MLAB)
Output data initial state	0	Unknown
Flushing	Not required	A minimum of 32 slow clock cycle flushings are required

Before any read-out operations, the applications data is first written (partially or entirely) into the FIFO2 Intel FPGA IP core. The data read operations can be in long continuous bursts or a single clock read. While there is no specific write or read limitation, the bandwidth utilization will be less efficient for short writes and/or reads due to incurred latencies.

The read interface of the FIFO2 Intel FPGA IP core is suitable for applications that does not perform back-pressure or for applications with a "cascaded" buffer further downstream.

For example,

- At MAC RX user interface, which typically cannot be back-pressured, which is equivalent to always read.
- Along MAX TX internal data path to harden Native PHY FIFO. The FIFO read operations may then be derived from the Native PHY FIFO partial full status.

User application can connect to the read interface of the FIFO2 Intel FPGA IP core directly to a small SCFIFO (or similar storage buffers) externally to change the read-to-data latency to be zero but at the expense of Fmax and resources.

In practice, all clocks run at several hundred MHz. This is because the FIFO2 Intel FPGA IP core is highly pipelined to run at very high Fmax, and is not be suitable for slow clocks due to the long latency.

4.4.1. Configuration Methods

Table 33. Configuration Methods

You can configure and build the FIFO2 Intel FPGA IP cores with methods shown in the following table.

Method	Description
Using the FIFO2 parameter editor.	Intel recommends using this method to build your FIFO2 Intel FPGA IP cores. It is an efficient way to configure and build the FIFO2 Intel FPGA IP cores. The FIFO2 parameter editor provides options that you can easily use to configure the FIFO2 Intel FPGA IP core. You can access the FIFO2 Intel FPGA IP core parameter editor in **Basic Functions ➤ On Chip Memory ➤ FIFO2** of the IP catalog.(10)
Manually instantiating the FIFO2 Intel FPGA IP cores.	Use this method only if you are an expert user. This method requires that you know the detailed specifications of the IP cores. You must ensure that the input and output ports used, and the parameter values assigned are valid for the FIFO2 Intel FPGA IP cores you instantiate for your target device.

4.4.2. Fmax Target Measuring Methodology

The specified Fmax target is measured using the following conditions:

- IP is compiled as a stand-alone component, and is wrapped inside a wrapper.
- The wrapper has 1 non-resettable flop layer to register all wrapper input and output ports except for clocks.
- The wrapper flop layer must be preserved through synthesis attributes:

```
(* altera_attribute = {"-name DONT_MERGE_REGISTER ON; -name
PRESERVE_REGISTER ON; -name ADV_NETLIST_OPT_ALLOWED NEVER_ALLOW"} *)
```

- All wrapper ports except for clocks are set as virtual pins.

Note: This measurement is not intended to validate actual IP performance when integrated into a real system.

4.4.3. Performance Considerations

A wider FIFO is implemented using either multiple narrow instances or a single wide instance of these building blocks. You can choose based on empirical data or through parameters.

(10) Do not use dcfifo or scfifo as the entity name for your FIFO2 Platform Designer system.

In the FIFO2 Intel FPGA IP core, the Fmax has higher priority than latency. To achieve the targeted Fmax, the design will be piped when necessary. Use the following estimated pipe stages (or latency) as guidelines:

Operation	Estimated Pipe Stages (Latency)
write to data available in storage	~2 read clocks
write pointer binary-to-gray conversion	~2 read clocks
write pointer cross-over to read logic	~4 read clocks
write pointer gray-to-binary conversion	~2 read clocks
write pointer and read pointer comparison result	~2 read clocks
user read to data available	~6 read clocks

4.4.4. FIFO2 Intel FPGA IP Features

You can configure the FIFO2 Intel FPGA IP core as either a DCFIFO or a SCFIFO by using the parameter editor of the FIFO2 Intel FPGA IP core. When the FIFO2 Intel FPGA IP core is configured as a SCFIFO, the relevant clock domain crossing (CDC) structure will not be synthesized.

The following figures show the timing diagrams for read and write operations for FIFO2 Intel FPGA IP core.

Figure 30. Write to Full with Write Protection

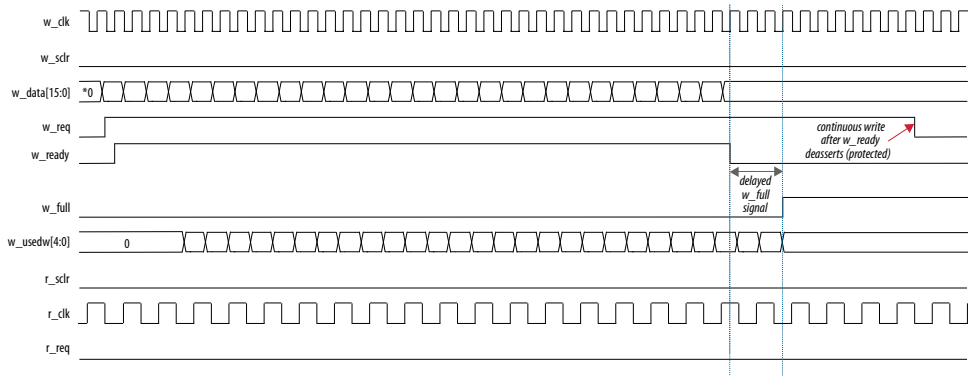
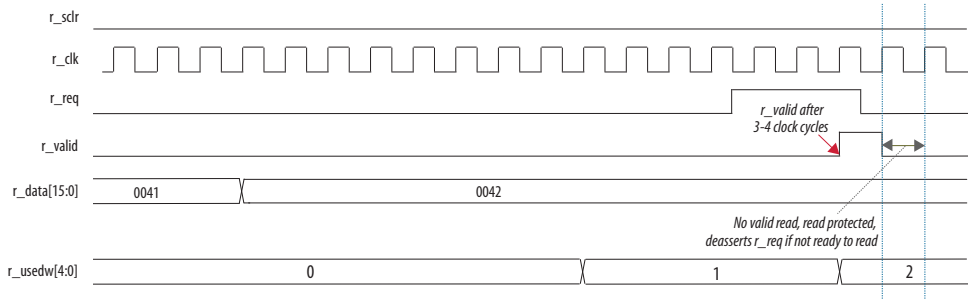


Figure 31. Single Read with Read Protection



4.4.4.1. FIFO2 Specifications

The following table summarizes the specifications of the FIFO2 Intel FPGA IP core.

Table 34. FIFO2 Specifications

Feature	Storage Type	
	M20K	MLAB
Error Checking and Correcting (ECC)	Always (11)	No
Read-out Interface	Analogy to Avalon ST non-zero readLatency For each r_req asserts now, r_valid shall indicate whether there is valid data to be taken (and must be taken) L clock later. L = 6	Analogy to Avalon ST non-zero readLatency For each r_req asserts now, r_valid shall indicate whether there is valid data to be taken (and must be taken) L clock later. L = 5
Width (bits)	There is no hard limit on user data width but the internal RAM block is always in 32b x N; where N > 0. Maximum = 4096b Default to 1.	There is no hard limit on user data width but the internal RAM block is always in 20b x N; where N > 0. Maximum = 4080b Default to 1.
Depth	512	32
Depth Stitching	No, user can cascade multiple FIFOs	No, user can cascade multiple FIFOs
Targeted Performance	Intel Stratix 10, bin1 production device 32bx512: Up to 850 MHz 512bx512: Up to 700 MHz	Intel Stratix 10, bin1 production device 20bx32: Up to 850 MHz 512bx32: Up to 700 MHz
Almost Full	No, user can derive this from "Write Used"	No, user can derive this from "Write Used"
Almost Empty	No, user can derive this from "Read Used"	No, user can derive this from "Read Used"
Read Used	Yes, delayed RAM block words measurement excluding in-flight data	Yes, delayed RAM block words measurement excluding in-flight data
Write Used	Yes, delayed RAM block words measurement excluding in-flight data	Yes, delayed RAM block words measurement excluding in-flight data
RAM with registered read output	Always	Always
Write full prevention	Always, based on internal almost full	Always, based on internal almost full
Read empty prevention	Always	Always
Output data initial states	Unknown	Unknown
Reset Scheme	Contains non resettable flops, requires state flushing	Contains non resettable flops, requires state flushing
RTL	Encrypted	Encrypted

(11) In the FIFO2 Intel FPGA IP core, the ECC mode is embedded within the IP architecture and cannot be disabled. Unlike FIFO Intel FPGA IP core, there is no ECCSTATUS signal that can be exported for use in your design.

4.4.5. FIFO2 Intel FPGA IP Parameters

Table 35. FIFO2 Intel FPGA IP Core Parameters Description

This table lists the parameters for the FIFO2 Intel FPGA IP core.

Parameter	Legal Values	Description
What type of FIFO you prefer?	• Single-clock • Dual-clock	Specifies the type of FIFO.
How wide should the FIFO be?	—	Specifies the width of the data and q ports.
RAM block type	• MLAB • M20K	Specifies the type of RAM Block used for FIFO
Parameter Settings: Reset Option		
Enable Asynchronous Clear (ACLR)	On/Off	Specifies the write and read are reset asynchronously.
Parameter Settings: Performance Optimization		
Enable per RAM block preserve/duplication for: • RAM write address * • RAM read address * * Note: This will typically increase Fmax at the expense of resources.	On/Off	Enables per RAM block preserve/ duplication for: • RAM write address: Specifies whether RAM write address (and associated logic where appropriate) should be duplicated per RAM block. • RAM read address: Specifies whether RAM read address (and associated logic where appropriate) should be duplicated per RAM block. Note: This will typically increase $_{MAX}$ at the expense of resources.
When you select **Dual-clock**, the following options are available: • The synchronizer chain length for write gray-code pointer • The synchronizer chain length for read gray-code pointer	3, 4	Specify the multi-flop synchronizer chain length for write and read gray-code pointers.

4.4.5.1. FIFO2 Parameter Settings

Table 36. FIFO2 Parameters Description

Parameter	Description
DATAWIDTH	**FIFO Write and Read Data Width.** The user width granularity is as below, depending on the RAM block type: • M20K: 32n; where n = 1 to 128 • MLAB: 20n; where n = 1 to 205 This allows up to 4096 bit width which should be more than enough for different applications. All unused bits (for example, bits that do not carry any information) should be tied-off. For instance, if the user data width were 20-bit and M20K RAM block is used, there would be 12 unused bits to be tied-off. The default value for n is 1.
SCFIFO_MODE	**SCFIFO Mode.**

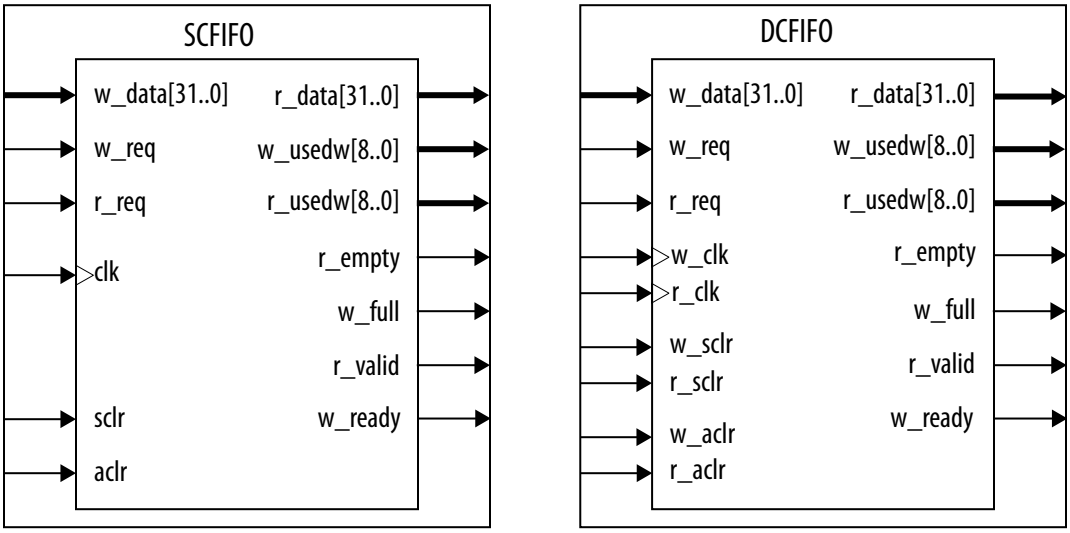
continued...

Parameter	Description
	Specify whether the FIFO should operate in SCFIFO mode, in which the clock crossing logic structure between Write and Read clock domains shall be removed. • 1— SCFIFO mode • 0 (default)—DCFIFO mode
RAM_BLK_TYPE	**RAM Block Type.** Specify the embedded RAM blocks to be used as the main FIFO storage. • "M20K" (default)—Use M20K • "MLAB"—Use MLAB
USE_ACLR_PORT	**Use Asynchronous Clear Port.** Specify whether the asynchronous reset ports (for example, `w_aclr` and `r_aclr`) of the IP should have effect. • 1—Ports are used to asynchronously reset the IP • 0 (default)—Ports are not used and have no effect
WRPTR_GRY_SYNC_CHAIN_LEN	**Write Gray-Code Pointer Synchronizer Chain Length.** Specify the number of flop stages used to synchronize Write Gray-Code Pointer to the `r_clk` domain. • 3 (default)—Use 3-stage synchronizer • 4—Use 4-stage synchronizer
RDPTR_GRY_SYNC_CHAIN_LEN	**Read Gray-Code Pointer Synchronizer Chain Length.** Specify the number of flop stages used to synchronize Read Gray-Code Pointer to the `w_clk` domain. • 3 (default)—Use 3-stage synchronizer • 4—Use 4-stage synchronizer
RAM_WRPTR_DUPLICATE	**RAM Write Address Duplication.** Specify whether RAM Write Address and associated logic (where appropriate) should be duplicated per RAM block. • 1—Enable per RAM block preserve/duplication. This may increase Fmax at the expense of resources • 0 (default)—Do not enable per RAM block preserve/duplication. You can determine which registers should be duplicated through assignment.
RAM_RDPTR_DUPLICATE	**RAM Read Address Duplication.** Specify whether RAM Read Address (and associated logic where appropriate should be duplicated per RAM block. U • 1—Enable per RAM block preserve/duplication. This may increase Fmax at the expense of resources • 0 (default)—Do not enable per RAM block preserve/duplication. You can determine which registers should be duplicated through assignment.

4.4.6. FIFO2 Intel FPGA IP Interface Signals

This section provides diagrams of the SCFIFO and DCFIFO blocks of the FIFO2 Intel FPGA IP core to help in visualizing their input and output ports. This section also describes each port in detail to help in understanding their usages, functionality, or any restrictions.

Figure 32. FIFO2 IP Core Input and Output Signals



4.4.6.1. SCFIFO Signals

Table 37. SCFIFO Input and Output Ports Description

Signal	Direction	Required	Description
clk	Input	Yes	FIFO Write Clock and Read Clock.
aclr	Input	No	Active-high reset signal that feeds the asynchronous clear pins of clk domain flip-flops. This reset is not synchronized within the IP, and hence, user logic should ensure it is de-asserted synchronously to clk whenever appropriate. This signal only takes effect if USE_ACLR_PORT is enabled. • 0 = reset inactive • 1 = reset active
sclr	Input	No	Active-high reset signal that feeds the synchronous clear pins of clk domain flip-flops. Reset sequence requirements must be followed. • 0 = request inactive • 1 = request active
w_req	Input	Yes	FIFO write request. This signal is expected to be inactive during reset. • 0 = request inactive • 1 = request active
w_data[FIFO_WIDTH-1:0]	Input	Yes	FIFO Write Data. This bus presents the data to be stored into the FIFO when there is a write request. The value is taken by the FIFO only when w_req is active, and the FIFO is not full (i.e. w_full = 1).
w_full	Output	No	FIFO Write Full. This signal indicates whether the space remained in the FIFO is about to run-out. When this signal asserts, further w_req is ignored. *Note:* Due to internal pipeline stages to improve Fmax, the actual usable space is a few entries less than that being configured to prevent data loss.

continued...

Signal	Direction	Required	Description
			• 0 = FIFO is not full • 1 = FIFO is (near) full
r_req	Input	Yes	FIFO Read Request / Read Ready. In order to hit the highest possible Fmax, the use model of this signal is slightly different from the normal zero read to data ready latency FIFO. User application is expected to assert this signal at the appropriate time to indicate its readiness to take in data some clock cycles (L) from now. At L clock later, r_valid shall be asserted if there is data available, or de-asserted if there is no data available at r_data port. This is analogous to the Avalon ST non-zero read latency valid/ready interface semantics and implies enough buffer spaces are allocated in downstream user application to consume in-flight data. • L = 5 when RAM_BLK_TYPE is "MLAB" • L = 6 when RAM_BLK_TYPE is "M20K" • 0 = read request inactive • 1 = read request active
r_data[FIFO_WIDTH-1:0]	Output	Yes	FIFO Read Data. This bus presents the data corresponds to each read request which have taken place some clock cycles earlier on. The read data is only valid in the clock cycle when r_valid asserts.
r_empty	Output	No	FIFO Read Empty. Indicate whether there is still data word remained in the FIFO. This effectively is a pipelined version of r_usedw == 0. This signal may be used by user application for monitoring purpose, or to initiate a series of read requests. • 0 = RAM block is not empty • 1 = RAM block is empty
r_valid	Output	No	FIFO Read Data Valid. Indicate whether the data at r_data output port is valid. Each r_valid assertion correspond to a previous read request/ready. Due to read request to data ready latency introduced by internal pipeline stages, this signal can still be asserted for several clocks after r_empty asserts. When r_valid asserts, data must be taken by the user application; else, it will be lost. The r_valid and r_req interface is analogous to the Avalon ST valid and ready semantics with non-zero read latency. • 0 = data is not valid • 1 = data is valid
w_ready	Output	Yes	Active-low write-protect signal to gate data on the write port, before the delayed w_full asserts.

4.4.6.2. DCFIFO Signals

Table 38. DCFIFO Input and Output Ports Description

Signal	Direction	Required	Description
w_clk	Input	Yes	FIFO Write Clock.
w_aclr	Input	No	Active-high reset signal that feeds the asynchronous clear pins of w_clk domain flip-flops. This reset is not synchronized within the IP, and hence, user logic should ensure it is de-asserted synchronously to w_clk whenever appropriate.

continued...

Signal	Direction	Required	Description
			This signal only takes effect if USE_ACLR_PORT is enabled. • 0 = reset inactive • 1 = reset active
w_sclr	Input	No	Active-high reset signal that feeds the synchronous clear pins of w_clk domain flip-flops. Reset sequence requirements must be followed. • 0 = request inactive • 1 = request active
r_clk	Input	Yes	FIFO Read Clock.
r_aclr	Input	No	Active-high reset signal that feeds the asynchronous clear pins of r_clk domain flip-flops. This reset is not synchronized within the IP, and hence, user logic should ensure it is de-asserted synchronously to r_clk whenever appropriate. In addition, reset sequence requirements must be followed. This signal only takes effect if USE_ACLR_PORT is enabled. • 0 = reset inactive • 1 = reset active
r_sclr	Input	No	Active-high reset signal that feeds the synchronous clear pins of r_clk domain flip-flops. Reset sequence requirements must be followed. • 0 = reset inactive • 1 = reset active
w_req	Input	Yes	FIFO write request. This signal is expected to be inactive during reset. • 0 = request inactive • 1 = request active
w_data[FIFO_WIDTH-1:0]	Input	Yes	FIFO Write Data. This bus presents the data to be stored into the FIFO when there is a write request. The value is taken by the FIFO only when w_req is active, and the FIFO is not full (i.e. w_full = 1).
w_full	Output	No	FIFO Write Full. This signal indicates whether the space remained in the FIFO is about to run-out. When this signal asserts, further w_req is ignored. *Note:* Due to internal pipeline stages to improve Fmax, the actual usable space is a few entries less than that being configured to prevent data loss. • 0 = FIFO is not full • 1 = FIFO is (near) full
r_req	Input	Yes	FIFO Read Request / Read Ready. To achieve the highest possible Fmax, the use model of this signal is slightly different from the normal zero read to data ready latency FIFO. User application is expected to assert this signal at the appropriate time to indicate its readiness to take in data some clock cycles (L) from now. At L clock later, r_valid shall be asserted if there is data available, or de-asserted if there is no data available at r_data port. This is analogous to the Avalon ST non-zero read latency valid/ready interface semantics and implies enough buffer spaces are allocated in the downstream user application to consume in-flight data. • L = 5 when RAM_BLK_TYPE is "MLAB" • L = 6 when RAM_BLK_TYPE is "M20K"

continued...

Signal	Direction	Required	Description
			• 0 = read request inactive • 1 = read request active
r_data[FIFO_WIDTH-1:0]	Output	Yes	FIFO Read Data. This bus presents the data corresponds to each read request, which have taken place some clock cycles earlier. The read data is only valid in the clock cycle when r_valid asserts.
r_empty	Output	No	FIFO Read Empty. Indicate whether there is still data word remained in the FIFO. This effectively is a pipelined version of r_usedw == 0. This signal may be used by user application for monitoring purpose, or to initiate a series of read requests. • 0 = RAM block is not empty • 1 = RAM block is empty
r_valid	Output	No	FIFO Read Data Valid. Indicate whether the data at r_data output port is valid. Each r_valid assertion correspond to a previous read request/ready. Due to read request to data ready latency introduced by internal pipeline stages, this signal can still be asserted for several clocks after r_empty asserts. When r_valid asserts, data must be taken by the user application; else, it will be lost. The r_valid and r_req interface is analogous to the Avalon ST valid and ready semantics with non-zero read latency. • 0 = data is not valid • 1 = data is valid
w_ready	Output	Yes	Active-low write-protect signal to gate data on the write port, before the delayed w_full asserts.

4.4.7. Reset and Clock Schemes

4.4.7.1. Clock Domains

The logic of the FIFO2 Intel FPGA IP core is separated into 2 clock domains internally:

- w_clk
- r_clk

For example, in the default IP setting for a DCFIFO, the 2 clock domains are assumed to be asynchronous with proper clock-crossing structure in place.

You can configure the FIFO2 IP core to operate as a SCFIFO by setting the SCFIFO_MODE parameter to 1. In this mode:

- All revelant clock crossing structure logic are not synthesized.
- Both w_clk and r_clk signals are tied together to the same source and timed synchronously.

4.4.7.2. Reset

To maximize Fmax, there are non-resettable flops (or registers) with undefined initial power and reset states. Unless the reset state of a given interface signal is specified, you must not assume the reset the non-resettable flops to be of a specific value during power up or reset. As part of reset sequence, you must ensure that the FIFO internal stale states are flushed before normal operations are started or resumed.

The FIFO2 Intel FPGA IP core exposes both asynchronous and synchronous clear ports per clock domain so that the user application has full control on how reset sequences, such as entering and exiting reset, should work. The clear events for both `w_clk` and `r_clk` clock domains come from the same source so that the logic in both domains are brought into or out of reset together nominally. For example, you can choose to reset the logic in one clock domain such as `r_clk`, instead of `w_clk`. However, some signals such as the FIFO fill level status take time to settle down to the right states. In this case, the user application must ensure those signals do not cause any unintentional side effect.

By default, the FIFO2 Intel FPGA IP core only samples synchronous clear but ignores the asynchronous clear ports. You have the option to turn on **Enable Asynchronous Clear (ACLR)** to enable the synchronous clear feature in the parameter editor of the FIFO2 IP cores. You can also choose to implement only the asynchronous clear reset scheme by tying the synchronous clear ports to their inactive states.

Note: Non-resettable registers within the IP core require state flushing, even when asynchronous clear ports are used.

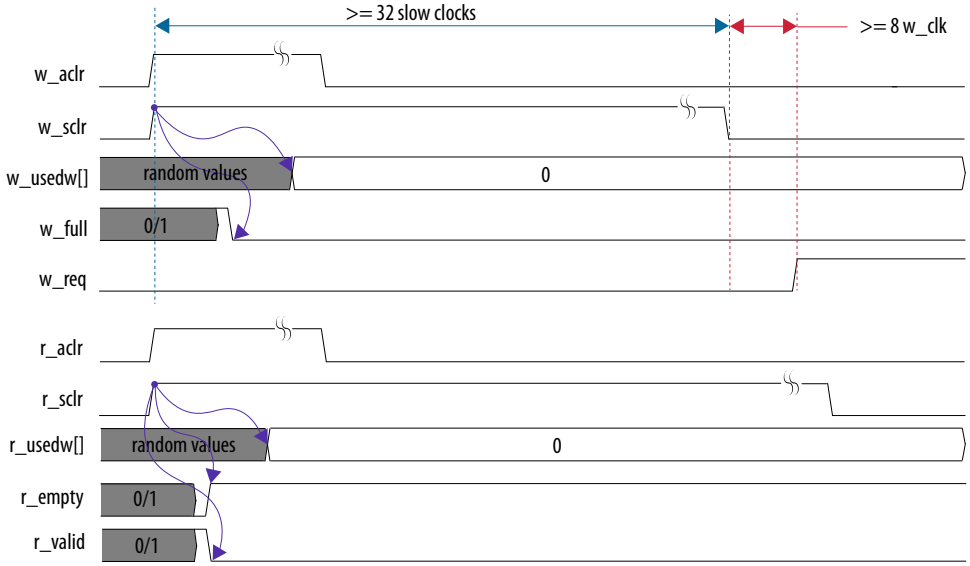
4.4.7.2.1. FIFO2 Intel FPGA IP Reset Guidelines

Use the following guidelines to provide a proper reset to the FIFO Intel FPGA IP core:

- Asynchronous clear is treated as a global IP reset event, and has the highest priority.
- If both asynchronous clear and synchronous clear are implemented:
  - When asynchronous clear asserts, the associated synchronous clear (for the clock domain) must also be asserted.
  - Asynchronous clear must be de-asserted first before synchronous clear (for the clock domain) de-asserts. Use synchronous clear to control when the IP should be out ofreset.
  - The asynchronous clear duration may be as short as 1 clock, but the synchronous clear must last for at least 32* slow clock cycles (clock must be toggling) to ensure all IP internal stale states are flushed.
- If only asynchronous or synchronous clear is implemented, the clear assertion duration must last for at least 32* slow clock cycles (clock must be toggling) to ensure all IP internal stale states are flushed.
- All clocks must be toggling valid for some time before asynchronous or synchronous clear deassertion.
- As some reset signals are internally pipelined, write operations must not be started within 8* clocks after reset de-assertion.

Figure 33. Reset Behavior

This figure shows the reset behavior of the FIFO2 Intel FPGA IP core.



Notes:

1. If used, assert w_aclr and r_aclr signals nominally at the same time.
2. Assert the associated *_sclr signal when when *_aclr signal is asserted.
3. Clocks must toggle the valid data for more than 32 slow clocks before *_sclr de-assertion to make sure that stale states are flushed.

A. Document Revision History for Intel Stratix 10 Embedded Memory User Guide

Document Version	Intel Quartus Prime Version	Changes
2018.05.07	18.0	• Updated the following IP cores as per Intel rebranding: — "RAM: 1-PORT" IP core to "RAM: 1-PORT Intel FPGA IP" — "RAM: 2-PORT" IP core to "RAM: 2-PORT Intel FPGA IP" — "RAM: 4-PORT" IP core to "RAM: 4-PORT Intel FPGA IP" — "ROM: 1-PORT" IP core to "ROM: 1-PORT Intel FPGA IP" — "ROM: 2-PORT" IP core to "ROM: 2-PORT Intel FPGA IP" — "Intel Stratix 10 Native eSRAM" IP core to "eSRAM Intel FPGA IP" — "FIFO" IP core to "FIFO Intel FPGA IP" — "FIFO2" IP core to "FIFO2 Intel FPGA IP" • Added new topics: — *ECC Read-During-Write Behavior* — *Forwarding Logic* • Updated Table: *Intel Stratix 10 Embedded Memory Features*: — Added Force-to-Zero support information — Removed packed mode feature. • Updated Table: *Embedded Memory Capacity and Distribution in Intel Stratix 10 Devices* to remove redundant table content on Intel Stratix 10 MX1650 and MX2100. • Updated the *Memory Blocks Error Correction Code Support* topic: — Updated the description for the ECC feature. — Updated the ECC status flag signals for eSRAM blocks • Updated the *ECC Parity Flip* topic to correct the parity bit sequence for double-adjacent-error correction. • Updated the *Error Correction Code Truth Table* topic: — Updated Figure: *ECC Block Diagram for M20K Memory*. — Update Table: *ECC Status Flags Truth Table for eSRAM*. • Updated the *Force-to-Zero* topic. • Updated the *Coherent Read Memory* topic: — Renamed topic title from *Coherent Read* to *Coherent Read Memory*. — Added new Figures: *Coherent Read with Unregistered Output* and *Coherent Read with Registered Output*. — Removed Figures: *1-level Pipelining Waveform* and *2-level Pipelining Waveform*. • Updated Table: *Memory Blocks Clocking Modes Supported for Each Memory Mode* to add a footnote for the read/write clock mode mode of true-dual-port mode. • Updated the *Mixed-Width Port Configurations:* — Added Table: *Supported Mixed-width Ratios for Intel Stratix 10.* • Removed Topic: *Mixed-Width Ratio Configurations*.

Document Version	Intel Quartus Prime Version	Changes
		• Updated the *True Dual Ports Dual Clock Emulator* topic: — Updated topic description to include information on *valid* signal. — Added new Figures: • *Output Condition of Port A* • *Output Condition of Port B* • *RDW Condition of Port A* • *RDW Condition of Port B* • Updated the *Intel Stratix 10 Embedded Memory Configurations* topic: — Updated Table: *Supported Embedded Memory Block Configurations* to correct the depth and programmable width for eSRAM. — Removed the note about Intel Stratix 10 devices do not natively support 1/32, 1/16, and 1/8 mixed-width port ratios. • Updated the *Consider Power-Up State and Memory Initialization* topic. • Updated Table: *Output Modes for Embedded Memory Blocks in Same-Port Read-During-Write Mode* to add a note include a note for *Don't Care* mode. • Added a Table: *Mixed Port Read-During-Write Output Behaviors*. • Updated the *RAM and ROM Intel FPGA IP Core* chapter: — Added *Changing Parameter Settings Manually* and *RAM and ROM Parameters* subtopics. — Updated Tables: • *RAM: 1-PORT Intel FPGA IP Core Parameter Settings* • *RAM: 2-PORT Intel FPGA IP Core Parameter Settings* • *RAM: 4-PORT Intel FPGA IP Core Parameter Settings* • *ROM: 2-PORT Intel FPGA IP Core Parameter Settings* • *ROM: 2-PORT Intel FPGA IP Core Parameter Settings* • *Interface Signals of the RAM and ROM Intel FPGA IP Cores* • Updated the *eSRAM Intel FPGA IP* — Updated Table: *eSRAM Specifications*: • Added a footnote to the clock frequency feature. • Corrected the clock frequency value of -2 speed grade from 200 MHz - 650 MHz to 200 MHz - 640 MHz. • Updated the write latency value from 0 to 0 + 1. • Added a footnote to the write latency feature. — Updated Table: *eSRAM Intel FPGA IP Core Parameter Editor: Channel Tab*. — Updated Table: *eSRAM Intel FPGA IP Core Input and Output Signals*: • Added a new interface signal—`iopll_lock2core`. • Updated the width of the `esram2f_clk` signal from 2 to 1. • Updated the description of the `esram2f_clk` signal. • Updated the width of `c<channel_number>_data_0` signal from '72 or 64' to '1-72'. — Updated the *eSRAM Intel FPGA IP Simulation Walkthrough* topic. • Updated *FIFO Intel FPGA IP* chapter: — Added *Reset Scheme* subtopic.

Document Version	Intel Quartus Prime Version	Changes
		• Updated the *FIFO2 Intel FPGA IP* chapter: — Updated Table: *Differences between FIFO and FIFO2 Intel FPGA IP Cores* to remove the reset scheme feature. — Updated Table: *FIFO2 Specifications*: • Added a footnote for M20K of the Error Checking and Correcting (ECC) feature. • Updated the description for MLAB of the Targeted Performance feature. — Renamed topic title *FIFO2 User-Configurable Parameters* to *FIFO2 Parameter Settings*. — Updated Figure: *FIFO2 IP Core Input and Output Signals*. — Updated Tables: *SCFIFO Input and Output Ports Description* and *DCFIFO Input and Output Ports Description* to include descriptions for w_ready signal. • Updated for latest Intel branding standards. • Made editorial updates throughout the document.

Date	Version	Changes
December 2017	2017.12.04	Updated the "Embedded Memory Capacity and Distribution in Intel Stratix 10 Devices" table: Corrected the total RAM Bit (Mbits) for Intel Stratix 10 GX, Intel Stratix 10 MX, and Intel Stratix 10 SX variants.
November 2017	2017.11.06	• Added a new feature—True Dual Ports Dual Clock Emulator. • Updated the *Intel Stratix 10 Embedded Memory Features* topic: Updated the number of banks for each channel in the eSRAM blocks from 40 banks to 42 banks. • Updated the "Intel Stratix 10 Embedded Memory Features" table: — Updated the description for eSRAM for the Mixed-port read-during-write and coherent read features. — Added freeze logic, hardware behavior, and TDP dual clock emulator features. • Updated the "Embedded Memory Capacity and Distribution in Intel Stratix 10 Devices" table: — Updated eSRAM block and RAM (Bit) values for Intel Stratix 10 GX and Intel Stratix 10 SX variants. — Added embedded memory capacity information for Intel Stratix 10 MX variant. — Updated the values of M20K and MLAB RAM Bits, and total RAM bits for TX1650 and TX2100 product lines for Intel Stratix 10 TX variant. • Updated the *Byte Enable in Intel Stratix 10 Embedded Memory Blocks* topic. • Updated the *Data Byte Output* subtopic. • Updated the *Asynchronous Clear and Synchronous Clear* topic: — Updated the topic description. — Updated Figures: "Behavior of Asynchronous Clear and Synchronous Clear In Registered Mode" and "Behavior for Asynchronous Clear and Synchronous Clear In Unregistered Mode". • Updated the *Memory Blocks Error Correction Code Support* topic: — Added a feature for memory blocks error correction code support—ECC Parity Flip. — Updated the description of the eSRAM Blocks. • Added "ECC Status Flags Truth Table for eSRAM" table in the *Error Correction Code Truth Table* subtopic.

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Date	Version	Changes
		• Updated the *Embedded Memory Operating Modes* topic; — Renamed topic as *Intel Stratix 10 Embedded Memory Supported IP Cores*. — Updated "Intel Stratix 10 Memory IP Cores" table: Added IP Core column and information for ROM: 2 PORT. • Updated the "Memory Blocks Clocking Modes Supported for Each Memory Mode" table: — Added Dual-Port ROM memory mode. — Added input/output clock mode support for True Dual-Port. — Removed FIFO memory mode. • Updated the note for the simple dual-port mode in the *Mixed-Width Ratio Configuration* topic. • Updated the "RAM in Mixed-Port Read-During-Write Mode" table: — Added a note to the *Don't Care* description for the *Don't Care* mode. — Added *New_a_old_b* mode to the table. — Added new Figure—Mixed-Port Read-During-Write: *New_a_old_b* Mode. • Updated the RAM: 1-PORT and RAM: 2-PORT IP cores topics in the *On-Chip Memory RAM and ROM IP Cores* section. • Updated the "RAM: 2-Port Parameter Setting" table: Added the Emulate TDP dual clock mode option. • Updated the "Interface Signals of the Intel Stratix 10 On-Chip Memory RAM and ROM IP Cores" table: — Updated the direction values for `eccencbypass` and `eccencparity` signals. — Added three signals—`address2_a`, `address2_b`, and `sclr`. — Removed four signals: `clocken2`, `clocken3`, `aclr0`, and `aclr1`. — Updated the description for `aclr` signal. • Renamed the topic *Intel Stratix 10 eSRAM IP Core* to *Intel Stratix 10 Native eSRAM IP Core* to align with Intel Quartus Prime naming. • Added eSRAM IP core references to the *Intel Stratix 10 Native eSRAM IP Core* topic. • Added FIFO IP core references to the *FIFO IP Core* topic. • Added FIFO2 IP core references to the *FIFO2 IP Core* topic. • Updated for latest branding standards. • Made editorial updates throughout the document.
May 2017	2017.05.08	• Removed parity bit support for MLAB blocks under the Error Correction Code (ECC) support feature in the Intel Stratix 10 Embedded Memory Features table. • Updated the descriptions for M20K and MLAB blocks under Error Correction code (ECC) support feature in the Intel Stratix 10 Embedded Memory Features table. • Updated the Embedded Memory Capacity and Distribution in Intel Stratix 10 Devices table to remove TX4500 and TX5500, which are no longer part of Intel Stratix 10 TX variant. • Updated the Byte Enable Controls in ×10 Data Width (MLAB) table. • Removed parity bit support for MLAB blocks in the Parity Bit topic. • Added notes to the Supported Embedded Memory Block Configurations table in the Intel Stratix 10 Embedded Memory Configurations topic. • Added Mixed-Width Ratio Configurations topic. • Added Freeze Logic topic. • Added the Implement clock-enable circuitry for use in a partial reconfiguration region option for the RAM: 1-PORT, RAM: 2-PORT, and RAM: 4-PORT IP cores. • Removed the Use different data widths on different ports option from RAM: 4-Port Parameter Settings table because this option is not available in RAM: 4-Port. • Added Hardware Behavior topic.

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Date	Version	Changes
		• Added figures for the Coherent Read topic. • Updated the feature description for ROM: 1-PORT and ROM: 2-PORT in the table of the On-Chip Memory RAM and ROM IP Cores topic. • Added `ecc_enc_bypass` and `ecc_enc_parity` signals in the Interface Signals of the Intel Stratix 10 On-Chip Memory RAM and ROM IP Cores table. • Added Intel Stratix 10 eSRAM IP core topic. • Minor typographical corrections.
October 2016	2016.10.31	Initial release